



# TPS65021 Power Management IC For Li-Ion or Li-Polymer Powered Systems

## 1 Features

- 1.2-A, 97% Efficient Step-Down Converter for System Voltage (VDCDC1)
- 1-A, Up to 95% Efficient Step-Down Converter for Memory Voltage (VDCDC2)
- 900-mA, 90% Efficient Step-Down Converter for Processor Core (VDCDC3)
- 30-mA LDO and Switch for Real-Time Clock (VRTC)
- 2 × 200-mA General-Purpose LDO
- Dynamic Voltage Management for Processor Core
- Preselectable LDO Voltage Using Two Digital Input Pins
- Externally Adjustable Reset Delay Time
- Battery Backup Functionality
- Separate Enable Pins for Inductive Converters
- I<sup>2</sup>C-Compatible Serial Interface
- 85-μA Quiescent Current
- Low-Ripple PFM Mode
- Thermal Shutdown Protection
- 40-Pin 6-mm × 6-mm VQFN Package

## 2 Applications

- PDAs
- Cellular and Smart Phones
- Internet Audio Players
- Digital Still Cameras
- Digital Radio Players
- Split-Supply TMS320™ DSP Family and μP Solutions: OMAP™1610, OMAP1710, OMAP330, XScale Bulverde, Samsung ARM-Based Processors, and so Forth
- Intel® PXA270, and so Forth

## 3 Description

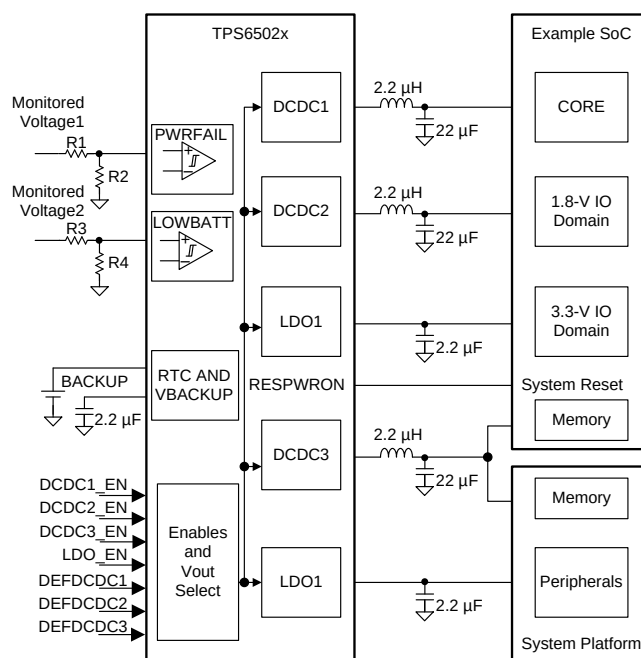
The TPS65021 device is an integrated power management IC for applications powered by one Li-Ion or Li-Polymer cell, and which requires multiple power rails. The TPS65021 device provides three highly efficient, step-down converters targeted at providing the core voltage, peripheral, I/O, and memory rails in a processor-based system. All three step-down converters enter a low-power mode at light load for maximum efficiency across the widest possible range of load currents.

### Device Information<sup>(1)</sup>

| PART NUMBER | PACKAGE   | BODY SIZE (NOM)   |
|-------------|-----------|-------------------|
| TPS65021    | VQFN (40) | 6.00 mm × 6.00 mm |

(1) For all available packages, see the orderable addendum at the end of the data sheet.

### Simplified Application Diagram



## Table of Contents

|                                                                                        |          |                                                                      |           |
|----------------------------------------------------------------------------------------|----------|----------------------------------------------------------------------|-----------|
| <b>1 Features</b> .....                                                                | <b>1</b> | <b>8 Detailed Description</b> .....                                  | <b>19</b> |
| <b>2 Applications</b> .....                                                            | <b>1</b> | 8.1 Overview .....                                                   | 19        |
| <b>3 Description</b> .....                                                             | <b>1</b> | 8.2 Functional Block Diagram .....                                   | 20        |
| <b>4 Revision History</b> .....                                                        | <b>2</b> | 8.3 Feature Description .....                                        | 21        |
| <b>5 Description (continued)</b> .....                                                 | <b>3</b> | 8.4 Device Functional Modes .....                                    | 25        |
| <b>6 Pin Configuration and Functions</b> .....                                         | <b>3</b> | 8.5 Programming .....                                                | 26        |
| <b>7 Specifications</b> .....                                                          | <b>5</b> | 8.6 Register Maps .....                                              | 29        |
| 7.1 Absolute Maximum Ratings .....                                                     | 5        | <b>9 Application and Implementation</b> .....                        | <b>35</b> |
| 7.2 ESD Ratings .....                                                                  | 5        | 9.1 Application Information .....                                    | 35        |
| 7.3 Recommended Operating Conditions .....                                             | 5        | 9.2 Typical Application .....                                        | 36        |
| 7.4 Thermal Information .....                                                          | 6        | <b>10 Power Supply Recommendations</b> .....                         | <b>41</b> |
| 7.5 Electrical Characteristics .....                                                   | 6        | 10.1 Requirements for Supply Voltages below 3.0 V ...                | 41        |
| 7.6 Electrical Characteristics: Supply Pins VCC,<br>VINDCDC1, VINDCDC2, VINDCDC3 ..... | 8        | <b>11 Layout</b> .....                                               | <b>42</b> |
| 7.7 Electrical Characteristics: Supply Pins VBACKUP,<br>VSYN, VRTC, VINLDO .....       | 8        | 11.1 Layout Guidelines .....                                         | 42        |
| 7.8 Electrical Characteristics: VDCDC1 Step-Down<br>Converter .....                    | 9        | 11.2 Layout Example .....                                            | 42        |
| 7.9 Electrical Characteristics: VDCDC2 Step-Down<br>Converter .....                    | 10       | <b>12 Device and Documentation Support</b> .....                     | <b>43</b> |
| 7.10 Electrical Characteristics: VDCDC3 Step-Down<br>Converter .....                   | 10       | 12.1 Device Support .....                                            | 43        |
| 7.11 Timing Requirements .....                                                         | 11       | 12.2 Community Resources .....                                       | 43        |
| 7.12 Typical Characteristics .....                                                     | 14       | 12.3 Trademarks .....                                                | 43        |
|                                                                                        |          | 12.4 Electrostatic Discharge Caution .....                           | 43        |
|                                                                                        |          | 12.5 Glossary .....                                                  | 43        |
|                                                                                        |          | <b>13 Mechanical, Packaging, and Orderable<br/>Information</b> ..... | <b>43</b> |

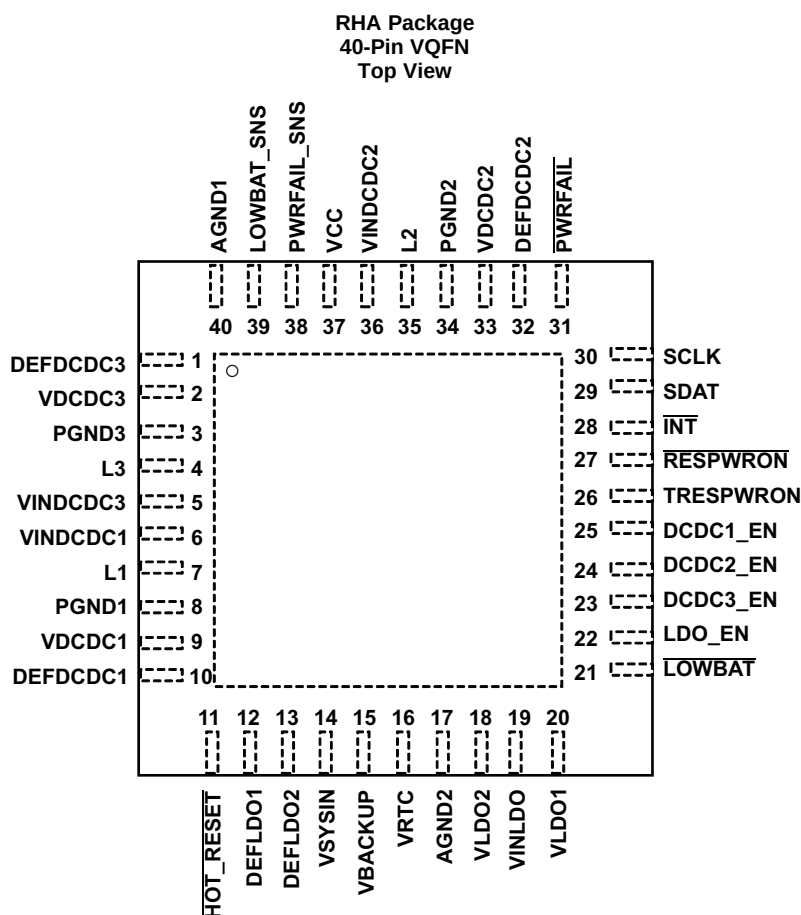
## 4 Revision History

| Changes from Revision C (September 2011) to Revision D                                                                                                                                                                                                                                                                                      | Page |
|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|------|
| <ul style="list-style-type: none"> <li>Added ESD Ratings table, Feature Description section, Device Functional Modes, Application and Implementation section, Power Supply Recommendations section, Layout section, Device and Documentation Support section, and Mechanical, Packaging, and Orderable Information section .....</li> </ul> | 1    |

## 5 Description (continued)

The TPS65021 device also integrates two general-purpose 200-mA LDO voltage regulators, which are enabled with an external input pin. Each LDO operates with an input voltage range from 1.5 V to 6.5 V, thus allowing them to be supplied from one of the step-down converters or directly from the battery. The default output voltage of the LDOs can be digitally set to 4 different voltage combinations using the DEFLDO1 and DEFLDO2 pins. The serial interface can be used for dynamic voltage scaling, masking interrupts, or for disabling or enabling and setting the LDO output voltages. The interface is compatible with both the fast and standard mode I<sup>2</sup>C specifications, allowing transfers at up to 400 kHz. The TPS65021 device is available in a 40-pin (RHA) VQFN package, and operates over a free-air temperature of –40°C to +85°C.

## 6 Pin Configuration and Functions



**Pin Functions**

| PIN                         |     | I/O | DESCRIPTION                                                                                                                                                                                                                              |
|-----------------------------|-----|-----|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| NAME                        | NO. |     |                                                                                                                                                                                                                                          |
| SWITCHING REGULATOR SECTION |     |     |                                                                                                                                                                                                                                          |
| AGND1                       | 40  | —   | Analog ground connection. All analog ground pins are connected internally on the chip.                                                                                                                                                   |
| AGND2                       | 17  | —   | Analog ground connection. All analog ground pins are connected internally on the chip.                                                                                                                                                   |
| DCDC1_EN                    | 25  | I   | VDCDC1 enable pin. A logic high enables the regulator, a logic low disables the regulator.                                                                                                                                               |
| DCDC2_EN                    | 24  | I   | VDCDC2 enable pin. A logic high enables the regulator, a logic low disables the regulator.                                                                                                                                               |
| DCDC3_EN                    | 23  | I   | VDCDC3 enable pin. A logic high enables the regulator, a logic low disables the regulator.                                                                                                                                               |
| DEFDCDC1                    | 10  | I   | Input signal indicating default VDCDC1 voltage, 0 = 3 V, 1 = 3.3 V This pin can also be connected to a resistor divider between VDCDC1 and GND. If the output voltage of the DCDC1 converter is set in a range from 0.6 V to VINDCDC1 V. |

### Pin Functions (continued)

| PIN                                       |     | I/O | DESCRIPTION                                                                                                                                                                                                                                 |
|-------------------------------------------|-----|-----|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| NAME                                      | NO. |     |                                                                                                                                                                                                                                             |
| DEFDCDC2                                  | 32  | I   | Input signal indicating default VDCDC2 voltage, 0 = 1.8 V, 1 = 2.5 V This pin can also be connected to a resistor divider between VDCDC2 and GND. If the output voltage of the DCDC2 converter is set in a range from 0.6 V to VINDCDC2 V.  |
| DEFDCDC3                                  | 1   | I   | Input signal indicating default VDCDC3 voltage, 0 = 1.3 V, 1 = 1.55 V This pin can also be connected to a resistor divider between VDCDC3 and GND. If the output voltage of the DCDC3 converter is set in a range from 0.6 V to VINDCDC3 V. |
| L1                                        | 7   | —   | Switch pin of VDCDC1 converter. The VDCDC1 inductor is connected here.                                                                                                                                                                      |
| L2                                        | 35  | —   | Switch pin of VDCDC2 converter. The VDCDC2 inductor is connected here.                                                                                                                                                                      |
| L3                                        | 4   | —   | Switch pin of VDCDC3 converter. The VDCDC3 inductor is connected here.                                                                                                                                                                      |
| PGND1                                     | 8   | —   | Power ground for VDCDC1 converter                                                                                                                                                                                                           |
| PGND2                                     | 34  | —   | Power ground for VDCDC2 converter                                                                                                                                                                                                           |
| PGND3                                     | 3   | —   | Power ground for VDCDC3 converter                                                                                                                                                                                                           |
| PowerPAD™                                 | —   | —   | Connect the power pad to analog ground                                                                                                                                                                                                      |
| VCC                                       | 37  | I   | Power supply for digital and analog circuitry of VDCDC1, VDCDC2, and VDCDC3 DC-DC converters. This must be connected to the same voltage supply as VINDCDC3, VINDCDC1, and VINDCDC2. Also supplies serial interface block                   |
| VDCDC1                                    | 9   | I   | VDCDC1 feedback voltage sense input, connect directly to VDCDC1                                                                                                                                                                             |
| VDCDC2                                    | 33  | I   | VDCDC2 feedback voltage sense input, connect directly to VDCDC2                                                                                                                                                                             |
| VDCDC3                                    | 2   | I   | VDCDC3 feedback voltage sense input, connect directly to VDCDC3                                                                                                                                                                             |
| VINDCDC1                                  | 6   | I   | Input voltage for VDCDC1 step-down converter. This must be connected to the same voltage supply as VINDCDC2, VINDCDC3, and VCC.                                                                                                             |
| VINDCDC2                                  | 36  | I   | Input voltage for VDCDC2 step-down converter. This must be connected to the same voltage supply as VINDCDC1, VINDCDC3, and VCC.                                                                                                             |
| VINDCDC3                                  | 5   | I   | Input voltage for VDCDC3 step-down converter. This must be connected to the same voltage supply as VINDCDC1, VINDCDC2, and VCC.                                                                                                             |
| <b>LDO REGULATOR SECTION</b>              |     |     |                                                                                                                                                                                                                                             |
| DEFLD01                                   | 12  | I   | Digital input, used to set default output voltage of LDO1 and LDO2                                                                                                                                                                          |
| DEFLD02                                   | 13  | I   | Digital input, used to set default output voltage of LDO1 and LDO2                                                                                                                                                                          |
| LDO_EN                                    | 22  | I   | Enable input for LDO1 and LDO2. Logic high enables the LDOs, logic low disables the LDOs                                                                                                                                                    |
| VBACKUP                                   | 15  | I   | Connect the backup battery to this input pin                                                                                                                                                                                                |
| VINLDO                                    | 19  | I   | I Input voltage for LDO1 and LDO2                                                                                                                                                                                                           |
| VLDO1                                     | 20  | O   | Output voltage of LDO1                                                                                                                                                                                                                      |
| VLDO2                                     | 18  | O   | Output voltage of LDO2                                                                                                                                                                                                                      |
| VRTC                                      | 16  | O   | Output voltage of the LDO and switch for the real-time clock                                                                                                                                                                                |
| VSYSIN                                    | 14  | I   | Input of system voltage for VRTC switch                                                                                                                                                                                                     |
| <b>CONTROL AND I<sup>2</sup>C SECTION</b> |     |     |                                                                                                                                                                                                                                             |
| HOT_RESET                                 | 11  | I   | Push button input used to reboot or wake-up processor through $\overline{\text{RESPWRON}}$ output pin                                                                                                                                       |
| $\overline{\text{INT}}$                   | 28  | O   | Open drain output                                                                                                                                                                                                                           |
| $\overline{\text{LOW\_BAT}}$              | 21  | O   | Open drain output of LOW_BAT comparator                                                                                                                                                                                                     |
| LOWBAT_SNS                                | 39  | I   | Input for the comparator driving the $\overline{\text{LOW\_BAT}}$ output.                                                                                                                                                                   |
| $\overline{\text{PWRFAIL}}$               | 31  | O   | Open drain output. Active low when $\overline{\text{PWRFAIL}}$ comparator indicates low VBAT condition.                                                                                                                                     |
| PWRFAIL_SNS                               | 38  | I   | Input for the comparator driving the $\overline{\text{PWRFAIL}}$ output.                                                                                                                                                                    |
| $\overline{\text{RESPWRON}}$              | 27  | O   | Open drain System reset output                                                                                                                                                                                                              |
| SCLK                                      | 30  | I   | Serial interface clock line                                                                                                                                                                                                                 |
| SDAT                                      | 29  | I/O | Serial interface data and address                                                                                                                                                                                                           |
| TRESPWRON                                 | 26  | I   | Connect the timing capacitor to this pin to set the reset delay time: 1 nF → 100 ms                                                                                                                                                         |

## 7 Specifications

### 7.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted)<sup>(1)</sup>

|                  |                                                                                | MIN  | MAX  | UNIT |
|------------------|--------------------------------------------------------------------------------|------|------|------|
| V <sub>I</sub>   | Input voltage range on all pins except AGND and PGND pins with respect to AGND | −0.3 | 7    | V    |
|                  | Current at VINDCDC1, L1, PGND1, VINDCDC2, L2, PGND2, VINDCDC3, L3, PGND3       |      | 2000 | mA   |
|                  | Peak Current at all other pins                                                 |      | 1000 | mA   |
| T <sub>A</sub>   | Operating free-air temperature                                                 | −40  | 85   | °C   |
| T <sub>J</sub>   | Maximum junction temperature                                                   |      | 125  | °C   |
| T <sub>stg</sub> | Storage temperature                                                            | −65  | 150  | °C   |

- (1) Stresses beyond those listed under *Absolute Maximum Ratings* may cause permanent damage to the device. These are stress ratings only, which do not imply functional operation of the device at these or any other conditions beyond those indicated under *Recommended Operating Conditions*. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

### 7.2 ESD Ratings

|                    |                         | VALUE                                                                          | UNIT  |
|--------------------|-------------------------|--------------------------------------------------------------------------------|-------|
| V <sub>(ESD)</sub> | Electrostatic discharge | Human-body model (HBM), per ANSI/ESDA/JEDEC JS-001 <sup>(1)</sup>              | ±2000 |
|                    |                         | Charged-device model (CDM), per JEDEC specification JESD22-C101 <sup>(2)</sup> | ±500  |

- (1) JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.  
(2) JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process.

### 7.3 Recommended Operating Conditions

over operating free-air temperature range (unless otherwise noted)

|                         |                                                                                                                        | MIN | NOM | MAX       | UNIT |
|-------------------------|------------------------------------------------------------------------------------------------------------------------|-----|-----|-----------|------|
| V <sub>CC</sub>         | Input voltage range step-down converters (VINDCDC1, VINDCDC2, VINDCDC3); pins need to be tied to the same voltage rail | 2.5 |     | 6         | V    |
| V <sub>O</sub>          | Output voltage range for VDCDC1 step-down converter <sup>(1)</sup>                                                     | 0.6 |     | VINDCDC1  | V    |
|                         | Output voltage range for VDCDC2 (mem) step-down converter <sup>(1)</sup>                                               | 0.6 |     | VINDCDC2  |      |
|                         | Output voltage range for VDCDC3 (core) step-down converter <sup>(1)</sup>                                              | 0.6 |     | VINDCDC3  |      |
| V <sub>I</sub>          | Input voltage range for LDOs (VINLDO1, VINLDO2)                                                                        | 1.5 |     | 6.5       | V    |
| V <sub>O</sub>          | Output voltage range for LDOs (VLDO1, VLDO2)                                                                           | 1   |     | VINLDO1-2 | V    |
| I <sub>O(DCDC2)</sub>   | Output current at L1                                                                                                   |     |     | 1200      | mA   |
|                         | Inductor at L1 <sup>(2)</sup>                                                                                          | 2.2 | 3.3 |           | μH   |
| C <sub>I(DCDC1)</sub>   | Input capacitor at VINDCDC1 <sup>(2)</sup>                                                                             | 10  |     |           | μF   |
| C <sub>O(DCDC1)</sub>   | Output capacitor at VDCDC1 <sup>(2)</sup>                                                                              | 10  | 22  |           | μF   |
| I <sub>O(DCDC2)</sub>   | Output current at L2                                                                                                   |     |     | 1000      | mA   |
|                         | Inductor at L2 <sup>(2)</sup>                                                                                          | 2.2 | 3.3 |           | μH   |
| C <sub>I(DCDC2)</sub>   | Input capacitor at VINDCDC2 <sup>(2)</sup>                                                                             | 10  |     |           | μF   |
| C <sub>O(DCDC2)</sub>   | Output capacitor at VDCDC2 <sup>(2)</sup>                                                                              | 10  | 22  |           | μF   |
| I <sub>O(DCDC3)</sub>   | Output current at L3                                                                                                   |     |     | 900       | mA   |
|                         | Inductor at L3 <sup>(2)</sup>                                                                                          | 2.2 | 3.3 |           | μH   |
| C <sub>I(DCDC3)</sub>   | Input capacitor at VINDCDC3 <sup>(2)</sup>                                                                             | 10  |     |           | μF   |
| C <sub>O(DCDC3)</sub>   | Output capacitor at VDCDC3 <sup>(2)</sup>                                                                              | 10  | 22  |           | μF   |
| C <sub>I(VCC)</sub>     | Input capacitor at VCC <sup>(2)</sup>                                                                                  | 1   |     |           | μF   |
| C <sub>I(VINLDO)</sub>  | Input capacitor at VINLDO <sup>(2)</sup>                                                                               | 1   |     |           | μF   |
| C <sub>O(VLDO1-2)</sub> | Output capacitor at VLDO1, VLDO2 <sup>(2)</sup>                                                                        | 2.2 |     |           | μF   |
| I <sub>O(VLDO1-2)</sub> | Output current at VLDO1, VLDO2                                                                                         |     |     | 200       | mA   |

- (1) When using an external resistor divider at DEFDCDC3, DEFDCDC2, DEFDCDC1

- (2) See [Application and Implementation](#) for more information.

## Recommended Operating Conditions (continued)

over operating free-air temperature range (unless otherwise noted)

|               |                                                                                     | MIN | NOM | MAX | UNIT               |
|---------------|-------------------------------------------------------------------------------------|-----|-----|-----|--------------------|
| $C_{O(VRTC)}$ | Output capacitor at VRTC <sup>(2)</sup>                                             | 4.7 |     |     | $\mu\text{F}$      |
| $T_A$         | Operating ambient temperature                                                       | –40 |     | 85  | $^{\circ}\text{C}$ |
| $T_J$         | Operating junction temperature                                                      | –40 |     | 125 | $^{\circ}\text{C}$ |
|               | Resistor from VINDCDC3, VINDCDC2, VINDCDC1 to VCC used for filtering <sup>(3)</sup> |     | 1   | 10  | $\Omega$           |

- (3) Up to 3 mA can flow into  $V_{CC}$  when all 3 converters are running in PWM. This resistor causes the UVLO threshold to be shifted accordingly.

## 7.4 Thermal Information

| THERMAL METRIC <sup>(1)</sup> |                                              | TPS65021   | UNIT                 |
|-------------------------------|----------------------------------------------|------------|----------------------|
|                               |                                              | RHA (VQFN) |                      |
|                               |                                              | 40 PINS    |                      |
| $R_{\theta JA}$               | Junction-to-ambient thermal resistance       | 31.6       | $^{\circ}\text{C/W}$ |
| $R_{\theta JC(top)}$          | Junction-to-case (top) thermal resistance    | 18.2       | $^{\circ}\text{C/W}$ |
| $R_{\theta JB}$               | Junction-to-board thermal resistance         | 6.6        | $^{\circ}\text{C/W}$ |
| $\Psi_{JT}$                   | Junction-to-top characterization parameter   | 0.2        | $^{\circ}\text{C/W}$ |
| $\Psi_{JB}$                   | Junction-to-board characterization parameter | 6.5        | $^{\circ}\text{C/W}$ |
| $R_{\theta JC(bot)}$          | Junction-to-case (bottom) thermal resistance | 1.7        | $^{\circ}\text{C/W}$ |

- (1) For more information about traditional and new thermal metrics, see the *Semiconductor and IC Package Thermal Metrics* application report ([SPRA953](#)).

## 7.5 Electrical Characteristics

VINDCDC1 = VINDCDC2 = VINDCDC3 = VCC = VINLDO = 3.6 V, VBACKUP = 3 V,  $T_A = -40^{\circ}\text{C}$  to  $+85^{\circ}\text{C}$  (unless otherwise noted)

| PARAMETER                                                                                      |                                                        | TEST CONDITIONS                                   | MIN   | TYP <sup>(1)</sup> | MAX   | UNIT |
|------------------------------------------------------------------------------------------------|--------------------------------------------------------|---------------------------------------------------|-------|--------------------|-------|------|
| CONTROL SIGNALS: SCLK, SDAT (INPUT), DCDC1_EN, DCDC2_EN, DCDC3_EN, LDO_EN, DEFLDO1, DEFLDO2    |                                                        |                                                   |       |                    |       |      |
| V <sub>IH</sub>                                                                                | High level input voltage                               | Rpullup at SCLK and SDAT = 4.7 kΩ, pulled to VRTC | 1.3   |                    | VCC   | V    |
| V <sub>IL</sub>                                                                                | Low level input voltage                                | Rpullup at SCLK and SDAT = 4.7 kΩ, pulled to VRTC | 0     |                    | 0.4   | V    |
| I <sub>H</sub>                                                                                 | Input bias current                                     |                                                   |       | 0.01               | 0.1   | μA   |
| CONTROL SIGNALS: <u>HOT_RESET</u>                                                              |                                                        |                                                   |       |                    |       |      |
| V <sub>IH</sub>                                                                                | High level input voltage                               |                                                   | 1.3   |                    | VCC   | V    |
| V <sub>IL</sub>                                                                                | Low level input voltage                                |                                                   | 0     |                    | 0.4   | V    |
| I <sub>IB</sub>                                                                                | Input bias current                                     |                                                   |       | 0.01               | 0.1   | μA   |
| t <sub>deglitch</sub>                                                                          | Deglitch time at <u>HOT_RESET</u>                      |                                                   | 25    | 30                 | 35    | ms   |
| CONTROL SIGNALS: <u>LOWBAT</u> , <u>PWRFAIL</u> , <u>RESPWRON</u> , <u>INT</u> , SDAT (OUTPUT) |                                                        |                                                   |       |                    |       |      |
| V <sub>OH</sub>                                                                                | High level output voltage                              |                                                   |       |                    | 6     | V    |
| V <sub>OL</sub>                                                                                | Low level output voltage                               | I <sub>IL</sub> = 5 mA                            | 0     |                    | 0.3   | V    |
| ICONST                                                                                         | Internal charge and discharge current on pin TRESPWRON | Used for generating <u>RESPWRON</u> delay         | 1.7   | 2                  | 2.3   | μA   |
| TRESPWRON_LOWTH                                                                                | Internal lower comparator threshold on pin TRESPWRON   | Used for generating <u>RESPWRON</u> delay         | 0.225 | 0.25               | 0.275 | V    |
| TRESPWRON_UPTH                                                                                 | Internal upper comparator threshold on pin TRESPWRON   | Used for generating <u>RESPWRON</u> delay         | 0.97  | 1                  | 1.103 | V    |
|                                                                                                | Duration of low pulse at <u>RESPWRON</u>               | External capacitor 1 nF                           |       | 100                |       | ms   |
|                                                                                                | Resetpwron threshold                                   | VRTC falling                                      | –3%   | 2.4                | 3%    | V    |
|                                                                                                | Resetpwron threshold                                   | VRTC rising                                       | –3%   | 2.52               | 3%    | V    |
| I <sub>LK</sub>                                                                                | Leakage current                                        | Output inactive high                              |       |                    | 0.1   | μA   |

- (1) Typical values are at  $T_A = 25^{\circ}\text{C}$

## Electrical Characteristics (continued)

VINDCDC1 = VINDCDC2 = VINDCDC3 = VCC = VINLDO = 3.6 V, VBACKUP = 3 V, T<sub>A</sub> = –40°C to +85°C (unless otherwise noted)

| PARAMETER                                            |                                                  | TEST CONDITIONS                                                           | MIN  | TYP <sup>(1)</sup> | MAX  | UNIT |
|------------------------------------------------------|--------------------------------------------------|---------------------------------------------------------------------------|------|--------------------|------|------|
| <b>VLDO1 AND VLDO2 LOW-DROPOUT REGULATORS</b>        |                                                  |                                                                           |      |                    |      |      |
| V <sub>I</sub>                                       | Input voltage range for LDO1, 2                  |                                                                           | 1.5  |                    | 6.5  | V    |
| V <sub>O</sub>                                       | LDO1 output voltage range                        |                                                                           | 1    |                    | 3.3  | V    |
| V <sub>O</sub>                                       | LDO2 output voltage range                        |                                                                           | 1    |                    | 3.3  | V    |
| I <sub>O</sub>                                       | Maximum output current for LDO1, LDO2            | V <sub>I</sub> = 1.8 V, V <sub>O</sub> = 1.3 V                            | 200  |                    |      | mA   |
|                                                      |                                                  | V <sub>I</sub> = 1.5 V, V <sub>O</sub> = 1.3 V                            |      | 120                |      |      |
| I <sub>(SC)</sub>                                    | LDO1 and LDO2 short-circuit current limit        | V <sub>(LDO1)</sub> = GND, V <sub>(LDO2)</sub> = GND                      |      |                    | 400  | mA   |
|                                                      | Minimum voltage drop at LDO1, LDO2               | I <sub>O</sub> = 50 mA, VINLDO = 1.8 V                                    |      |                    | 120  | mV   |
|                                                      |                                                  | I <sub>O</sub> = 50 mA, VINLDO = 1.5 V                                    |      | 65                 | 150  |      |
|                                                      |                                                  | I <sub>O</sub> = 200 mA, VINLDO = 1.8 V                                   |      |                    | 300  |      |
|                                                      | Output voltage accuracy for LDO1, LDO2           | I <sub>O</sub> = 10 mA                                                    | –2%  |                    | 1%   |      |
|                                                      | Line regulation for LDO1, LDO2                   | VINLDO1,2 = VLDO1,2 + 0.5 V (min. 2.5 V) to 6.5 V, I <sub>O</sub> = 10 mA | –1%  |                    | 1%   |      |
|                                                      | Load regulation for LDO1, LDO2                   | I <sub>O</sub> = 0 mA to 50 mA                                            | –1%  |                    | 1%   |      |
|                                                      | Regulation time for LDO1, LDO2                   | Load change from 10% to 90%                                               |      | 10                 |      | μs   |
| <b>ANALOGIC SIGNALS DEFDCDC1, DEFDCDC2, DEFDCDC3</b> |                                                  |                                                                           |      |                    |      |      |
| V <sub>IH</sub>                                      | High level input voltage                         |                                                                           | 1.3  |                    | VCC  | V    |
| V <sub>IL</sub>                                      | Low level input voltage                          |                                                                           | 0    |                    | 0.1  | V    |
|                                                      | Input bias current                               |                                                                           |      | 0.001              | 0.05 | μA   |
| <b>THERMAL SHUTDOWN</b>                              |                                                  |                                                                           |      |                    |      |      |
| T <sub>(SD)</sub>                                    | Thermal shutdown                                 | Increasing junction temperature                                           |      | 160                |      | °C   |
|                                                      | Thermal shutdown hysteresis                      | Decreasing junction temperature                                           |      | 20                 |      | °C   |
| <b>INTERNAL UNDERVOLTAGE LOCKOUT</b>                 |                                                  |                                                                           |      |                    |      |      |
| UVLO                                                 | Internal UVLO                                    | VCC falling                                                               | –2%  | 2.35               | 2%   | V    |
| V <sub>(UVLO_HYST)</sub>                             | Internal UVLO comparator hysteresis              |                                                                           |      | 120                |      | mV   |
| <b>VOLTAGE DETECTOR COMPARATORS</b>                  |                                                  |                                                                           |      |                    |      |      |
|                                                      | Comparator threshold (PWRFAIL_SNS, LOWBAT_SNS)   | Falling threshold                                                         | –1%  | 1                  | 1%   | V    |
|                                                      | Hysteresis                                       |                                                                           | 40   | 50                 | 60   | mV   |
|                                                      | Propagation delay                                | 25 mV overdrive                                                           |      |                    | 10   | μs   |
| <b>POWER-GOOD</b>                                    |                                                  |                                                                           |      |                    |      |      |
| V <sub>(PGOODF)</sub>                                | VDCDC1, VDCDC2, VDCDC3, VLDO1, VLDO2, decreasing |                                                                           | –12% | –10%               | –8%  |      |
| V <sub>(PGOODR)</sub>                                | VDCDC1, VDCDC2, VDCDC3, VLDO1, VLDO2, increasing |                                                                           | –7%  | –5%                | –3%  |      |

## 7.6 Electrical Characteristics: Supply Pins VCC, VINDCDC1, VINDCDC2, VINDCDC3

VINDCDC1 = VINDCDC2 = VINDCDC3 = VCC = VINLDO = 3.6 V, VBACKUP = 3 V, T<sub>A</sub> = –40°C to +85°C (unless otherwise noted)

| PARAMETER                                         | TEST CONDITIONS                                                          | MIN                                                      | TYP <sup>(1)</sup> | MAX | UNIT |
|---------------------------------------------------|--------------------------------------------------------------------------|----------------------------------------------------------|--------------------|-----|------|
| I <sub>(q)</sub> Operating quiescent current, PFM | All 3 DCDC converters enabled, zero load and no switching, LDOs enabled  | VCC = 3.6 V, VBACKUP = 3 V;<br>V <sub>(VSYN)</sub> = 0 V | 85                 | 100 | μA   |
|                                                   | All 3 DCDC converters enabled, zero load and no switching, LDOs off      | VCC = 3.6 V, VBACKUP = 3 V;<br>V <sub>(VSYN)</sub> = 0 V | 78                 | 90  |      |
|                                                   | DCDC1 and DCDC2 converters enabled, zero load and no switching, LDOs off | VCC = 3.6 V, VBACKUP = 3 V;<br>V <sub>(VSYN)</sub> = 0 V | 57                 | 70  |      |
|                                                   | DCDC1 converter enabled, zero load and no switching, LDOs off            | VCC = 3.6 V, VBACKUP = 3 V;<br>V <sub>(VSYN)</sub> = 0 V | 43                 | 55  |      |
| I <sub>I</sub> Current into VCC; PWM              | All 3 DCDC converters enabled and running in PWM, LDOs off               | VCC = 3.6 V, VBACKUP = 3 V;<br>V <sub>(VSYN)</sub> = 0 V | 2                  | 3   | mA   |
|                                                   | DCDC1 and DCDC2 converters enabled and running in PWM, LDOs off          | VCC = 3.6 V, VBACKUP = 3 V;<br>V <sub>(VSYN)</sub> = 0 V | 1.5                | 2.5 |      |
|                                                   | DCDC1 converter enabled and running in PWM, LDOs off                     | VCC = 3.6 V, VBACKUP = 3 V;<br>V <sub>(VSYN)</sub> = 0 V | 0.85               | 2   |      |
| I <sub>(q)</sub> Quiescent current                | All converters disabled, LDOs off                                        | VCC = 3.6 V, VBACKUP = 3 V;<br>V <sub>(VSYN)</sub> = 0 V | 23                 | 33  | μA   |
|                                                   |                                                                          | VCC = 2.6 V, VBACKUP = 3 V;<br>V <sub>(VSYN)</sub> = 0 V | 3.5                | 5   | μA   |
|                                                   |                                                                          | VCC = 3.6 V, VBACKUP = 0 V;<br>V <sub>(VSYN)</sub> = 0 V |                    | 43  | μA   |

(1) Typical values are at T<sub>A</sub> = 25°C

## 7.7 Electrical Characteristics: Supply Pins VBACKUP, VSYN, VRTC, VINLDO

VINDCDC1 = VINDCDC2 = VINDCDC3 = VCC = VINLDO = 3.6 V, VBACKUP = 3 V, T<sub>A</sub> = –40°C to +85°C (unless otherwise noted)

| PARAMETER                                       | TEST CONDITIONS                                                 | MIN  | TYP <sup>(1)</sup> | MAX  | UNIT |
|-------------------------------------------------|-----------------------------------------------------------------|------|--------------------|------|------|
| <b>VBACKUP, VSYN, VRTC</b>                      |                                                                 |      |                    |      |      |
| I <sub>(q)</sub> Operating quiescent current    | VBACKUP = 3 V, VSYN = 0 V;<br>VCC = 2.6 V, current into VBACKUP |      | 20                 | 33   | μA   |
| I <sub>(SD)</sub> Operating quiescent current   | VBACKUP < V <sub>VBACKUP</sub> , current into VBACKUP           |      | 2                  | 3    | μA   |
| VRTC LDO output voltage                         | VSYN = VBACKUP = 0 V, I <sub>O</sub> = 0 mA                     |      | 3                  |      | V    |
| I <sub>O</sub> Output current for VRTC          | VSYN < 2.57 V and VBACKUP < 2.57 V                              |      |                    | 30   | mA   |
| VRTC short-circuit current limit                | VRTC = GND; VSYN = VBACKUP = 0 V                                |      |                    | 100  | mA   |
| Maximum output current at VRTC for RESPWRON = 1 | VRTC > 2.6 V, V <sub>CC</sub> = 3 V;<br>VSYN = VBACKUP = 0 V    | 30   |                    |      | mA   |
| V <sub>O</sub> Output voltage accuracy for VRTC | VSYN = VBACKUP = 0 V; I <sub>O</sub> = 0 mA                     | –1%  |                    | 1%   |      |
| Line regulation for VRTC                        | VCC = VRTC + 0.5 V to 6.5 V, I <sub>O</sub> = 5 mA              | –1%  |                    | 1%   |      |
| Load regulation VRTC                            | I <sub>O</sub> = 1 mA to 30 mA;<br>VSYN = VBACKUP = 0 V         | –3%  |                    | 1%   |      |
| Regulation time for VRTC                        | Load change from 10% to 90%                                     |      | 10                 |      | μs   |
| I <sub>lk</sub> Input leakage current at VSYN   | VSYN < V <sub>VSYN</sub>                                        |      |                    | 2    | μA   |
| r <sub>DS(on)</sub> of VSYN switch              |                                                                 |      |                    | 12.5 | Ω    |
| r <sub>DS(on)</sub> of VBACKUP switch           |                                                                 |      |                    | 12.5 | Ω    |
| Input voltage range at VBACKUP <sup>(2)</sup>   |                                                                 | 2.73 |                    | 3.75 | V    |
| Input voltage range at VSYN <sup>(2)</sup>      |                                                                 | 2.73 |                    | 3.75 | V    |
| VSYN threshold                                  | VSYN falling                                                    | –3%  | 2.55               | 3%   | V    |
| VSYN threshold                                  | VSYN rising                                                     | –3%  | 2.65               | 3%   | V    |
| VBACKUP threshold                               | VBACKUP falling                                                 | –3%  | 2.55               | 3%   | V    |
| VBACKUP threshold                               | VBACKUP falling                                                 | –3%  | 2.65               | 3%   | V    |

(1) Typical values are at T<sub>A</sub> = 25°C

(2) Based on the requirements for the Intel PXA270 processor.

## Electrical Characteristics: Supply Pins VBACKUP, VSYSIN, VRTC, VINLDO (continued)

VINDCDC1 = VINDCDC2 = VINDCDC3 = VCC = VINLDO = 3.6 V, VBACKUP = 3 V,  $T_A = -40^{\circ}\text{C}$  to  $+85^{\circ}\text{C}$  (unless otherwise noted)

| PARAMETER                             | TEST CONDITIONS                                     | MIN | TYP <sup>(1)</sup> | MAX | UNIT          |
|---------------------------------------|-----------------------------------------------------|-----|--------------------|-----|---------------|
| <b>VINLDO</b>                         |                                                     |     |                    |     |               |
| $I_{(q)}$ Operating quiescent current | Current per LDO into VINLDO                         |     | 16                 | 30  | $\mu\text{A}$ |
| $I_{(SD)}$ Shutdown current           | Total current for both LDOs into VINLDO, VLDO = 0 V |     | 0.1                | 1   | $\mu\text{A}$ |

## 7.8 Electrical Characteristics: VDCDC1 Step-Down Converter

VINDCDC1 = VINDCDC2 = VINDCDC3 = VCC = VINLDO = 3.6 V, VBACKUP = 3 V,  $T_A = -40^{\circ}\text{C}$  to  $+85^{\circ}\text{C}$  (unless otherwise noted)

| PARAMETER                                                                   | TEST CONDITIONS                                                                     | MIN                                                           | TYP <sup>(1)</sup> | MAX   | UNIT          |
|-----------------------------------------------------------------------------|-------------------------------------------------------------------------------------|---------------------------------------------------------------|--------------------|-------|---------------|
| $V_I$ Input voltage range, VINDCDC1                                         |                                                                                     | 2.5                                                           |                    | 6     | V             |
| $I_O$ Maximum output current                                                |                                                                                     | 1200                                                          |                    |       | mA            |
| $I_{(SD)}$ Shutdown supply current in VINDCDC1                              | DCDC1_EN = GND                                                                      |                                                               | 0.1                | 1     | $\mu\text{A}$ |
| $r_{DS(on)}$ P-channel MOSFET ON-resistance                                 | VINDCDC1 = $V_{(GS)} = 3.6\text{ V}$                                                |                                                               | 125                | 261   | m $\Omega$    |
| $I_{(kg)}$ P-channel leakage current                                        | VINDCDC1 = 6 V                                                                      |                                                               |                    | 2     | $\mu\text{A}$ |
| $r_{DS(on)}$ N-channel MOSFET ON-resistance                                 | VINDCDC1 = $V_{(GS)} = 3.6\text{ V}$                                                |                                                               | 130                | 260   | m $\Omega$    |
| $I_{(kg)}$ N-channel leakage current                                        | $V_{(DS)} = 6\text{ V}$                                                             |                                                               | 7                  | 10    | $\mu\text{A}$ |
| Forward current limit (P- and N-channel)                                    | $2.5\text{ V} < V_{I(MAIN)} < 6\text{ V}$                                           | 1.55                                                          | 1.75               | 1.95  | A             |
| $f_S$ Oscillator frequency                                                  |                                                                                     | 1.3                                                           | 1.5                | 1.7   | MHz           |
| Fixed output voltage<br>FPWMDCDC1=0                                         | 3 V                                                                                 | VINDCDC1 = 3.3 V to 6 V;<br>0 mA $\leq I_O \leq 1.2\text{ A}$ |                    | -2%   | 2%            |
|                                                                             | 3.3 V                                                                               | VINDCDC1 = 3.6 V to 6 V;<br>0 mA $\leq I_O \leq 1.2\text{ A}$ |                    | -2%   | 2%            |
| Fixed output voltage<br>FPWMDCDC1=1                                         | 3 V                                                                                 | VINDCDC1 = 3.3 V to 6 V;<br>0 mA $\leq I_O \leq 1.2\text{ A}$ |                    | -1%   | 1%            |
|                                                                             | 3.3 V                                                                               | VINDCDC1 = 3.6 V to 6 V;<br>0 mA $\leq I_O \leq 1.2\text{ A}$ |                    | -1%   | 1%            |
| Adjustable output voltage with resistor<br>divider at DEFDCDC1; FPWMDCDC1=0 | VINDCDC1 = VDCDC1 + 0.3 V (min. 2.5 V)<br>to 6 V; 0 mA $\leq I_O \leq 1.2\text{ A}$ |                                                               |                    | -2%   | 2%            |
| Adjustable output voltage with resistor<br>divider at DEFDCDC1; FPWMDCDC1=1 | VINDCDC1 = VDCDC1 + 0.3 V (min. 2.5 V)<br>to 6 V; 0 mA $\leq I_O \leq 1.2\text{ A}$ |                                                               |                    | -1%   | 1%            |
| Line Regulation                                                             | VINDCDC1 = VDCDC1 + 0.3 V (min. 2.5 V)<br>to 6 V; $I_O = 10\text{ mA}$              |                                                               |                    | 0%    | V             |
| Load Regulation                                                             | $I_O = 10\text{ mA}$ to 1200 mA                                                     |                                                               |                    | 0.25% | A             |
| Soft-start ramp time                                                        | VDCDC1 ramping from 5% to 95% of target<br>value                                    |                                                               |                    | 750   | $\mu\text{s}$ |
| Internal resistance from L1 to GND                                          |                                                                                     |                                                               |                    | 1     | M $\Omega$    |
| VDCDC1 discharge resistance                                                 | DCDC1 discharge = 1                                                                 |                                                               |                    | 300   | $\Omega$      |

(1) Typical values are at  $T_A = 25^{\circ}\text{C}$

## 7.9 Electrical Characteristics: VDCDC2 Step-Down Converter

VINDCDC1 = VINDCDC2 = VINDCDC3 = VCC = VINLDO = 3.6 V, VBACKUP = 3 V, T<sub>A</sub> = –40°C to +85°C (unless otherwise noted)

| PARAMETER                                                                   |                                          | TEST CONDITIONS                                                               | MIN  | TYP <sup>(1)</sup> | MAX | UNIT |
|-----------------------------------------------------------------------------|------------------------------------------|-------------------------------------------------------------------------------|------|--------------------|-----|------|
| V <sub>I</sub>                                                              | Input voltage range, VINDCDC2            |                                                                               | 2.5  |                    | 6   | V    |
| I <sub>O</sub>                                                              | Maximum output current                   |                                                                               | 1000 |                    |     | mA   |
| I <sub>(SD)</sub>                                                           | Shutdown supply current in VINDCDC2      | DCDC2_EN = GND                                                                |      | 0.1                | 1   | μA   |
| r <sub>DS(on)</sub>                                                         | P-channel MOSFET ON-resistance           | VINDCDC2 = V <sub>(GS)</sub> = 3.6 V                                          |      | 140                | 300 | mΩ   |
| I <sub>lkg</sub>                                                            | P-channel leakage current                | VINDCDC2 = 6 V                                                                |      |                    | 2   | μA   |
| r <sub>DS(on)</sub>                                                         | N-channel MOSFET ON-resistance           | VINDCDC2 = V <sub>(GS)</sub> = 3.6 V                                          |      | 150                | 297 | mΩ   |
| I <sub>lkg</sub>                                                            | N-channel leakage current                | V <sub>(DS)</sub> = 6 V                                                       |      | 7                  | 10  | μA   |
| I <sub>LIMF</sub>                                                           | Forward current limit (P- and N-channel) | 2.5 V < VINDCDC2 < 6 V                                                        | 1.4  | 1.55               | 1.7 | A    |
| f <sub>S</sub>                                                              | Oscillator frequency                     |                                                                               | 1.3  | 1.5                | 1.7 | MHz  |
| Fixed output voltage<br>FPWMDCDC2=0                                         | 1.8 V                                    | VINDCDC2 = 2.5 V to 6 V;<br>0 mA ≤ I <sub>O</sub> ≤ 1 A                       | –2%  |                    | 2%  |      |
|                                                                             | 2.5 V                                    | VINDCDC2 = 2.8 V to 6 V;<br>0 mA ≤ I <sub>O</sub> ≤ 1 A                       | –2%  |                    | 2%  |      |
| Fixed output voltage<br>FPWMDCDC2=1                                         | 1.8 V                                    | VINDCDC2 = 2.5 V to 6 V;<br>0 mA ≤ I <sub>O</sub> ≤ 1 A                       | –2%  |                    | 2%  |      |
|                                                                             | 2.5 V                                    | VINDCDC2 = 2.8 V to 6 V;<br>0 mA ≤ I <sub>O</sub> ≤ 1 A                       | –1%  |                    | 1%  |      |
| Adjustable output voltage with resistor divider<br>at DEFDCDC2 FPWMDCDC2=0  |                                          | VINDCDC2 = VDCDC2 + 0.3 V (min. 2.5 V)<br>to 6 V; 0 mA ≤ I <sub>O</sub> ≤ 1 A | –2%  |                    | 2%  |      |
| Adjustable output voltage with resistor divider<br>at DEFDCDC2; FPWMDCDC2=1 |                                          | VINDCDC2 = VDCDC2 + 0.3 V (min. 2.5 V)<br>to 6 V; 0 mA ≤ I <sub>O</sub> ≤ 1 A | –1%  |                    | 1%  |      |
| Line Regulation                                                             |                                          | VINDCDC2 = VDCDC2 + 0.3 V (min. 2.5 V)<br>to 6 V; I <sub>O</sub> = 10 mA      |      | 0%                 |     | V    |
| Load Regulation                                                             |                                          | I <sub>O</sub> = 10 mA to 1 mA                                                |      | 0.25%              |     | A    |
| Soft-start ramp time                                                        |                                          | VDCDC2 ramping from 5% to 95% of target<br>value                              |      | 750                |     | μs   |
| Internal resistance from L2 to GND                                          |                                          |                                                                               |      | 1                  |     | MΩ   |
| VDCDC2 discharge resistance                                                 |                                          | DCDC2 discharge = 1                                                           |      | 300                |     | Ω    |

(1) Typical values are at T<sub>A</sub> = 25°C

## 7.10 Electrical Characteristics: VDCDC3 Step-Down Converter

VINDCDC1 = VINDCDC2 = VINDCDC3 = VCC = VINLDO = 3.6 V, VBACKUP = 3 V, T<sub>A</sub> = –40°C to +85°C (unless otherwise noted)

| PARAMETER                                |                                     | TEST CONDITIONS                                            | MIN  | TYP <sup>(1)</sup> | MAX  | UNIT |
|------------------------------------------|-------------------------------------|------------------------------------------------------------|------|--------------------|------|------|
| V <sub>I</sub>                           | Input voltage range, VINDCDC3       |                                                            | 2.5  |                    | 6    | V    |
| I <sub>O</sub>                           | Maximum output current              |                                                            | 900  |                    |      | mA   |
| I <sub>(SD)</sub>                        | Shutdown supply current in VINDCDC3 | DCDC3_EN = GND                                             |      | 0.1                | 1    | μA   |
| r <sub>DS(on)</sub>                      | P-channel MOSFET ON-resistance      | VINDCDC3 = V <sub>(GS)</sub> = 3.6 V                       |      | 310                | 698  | mΩ   |
| I <sub>lkg</sub>                         | P-channel leakage current           | VINDCDC3 = 6 V                                             |      | 0.1                | 2    | μA   |
| r <sub>DS(on)</sub>                      | N-channel MOSFET ON-resistance      | VINDCDC3 = V <sub>(GS)</sub> = 3.6 V                       |      | 220                | 503  | mΩ   |
| I <sub>lkg</sub>                         | N-channel leakage current           | V <sub>(DS)</sub> = 6 V                                    |      | 7                  | 10   | μA   |
| Forward current limit (P- and N-channel) |                                     | 2.5 V < VINDCDC3 < 6 V                                     | 1.15 | 1.34               | 1.52 | A    |
| f <sub>S</sub>                           | Oscillator frequency                |                                                            | 1.3  | 1.5                | 1.7  | MHz  |
| Fixed output voltage<br>FPWMDCDC3=0      | All VDCDC3                          | VINDCDC3 = 2.5 V to 6 V;<br>0 mA ≤ I <sub>O</sub> ≤ 800 mA | –2%  |                    | 2%   |      |
|                                          |                                     | VINDCDC3 = 2.5 V to 6 V;<br>0 mA ≤ I <sub>O</sub> ≤ 800 mA | –1%  |                    | 1%   |      |

(1) Typical values are at T<sub>A</sub> = 25°C

## Electrical Characteristics: VDCDC3 Step-Down Converter (continued)

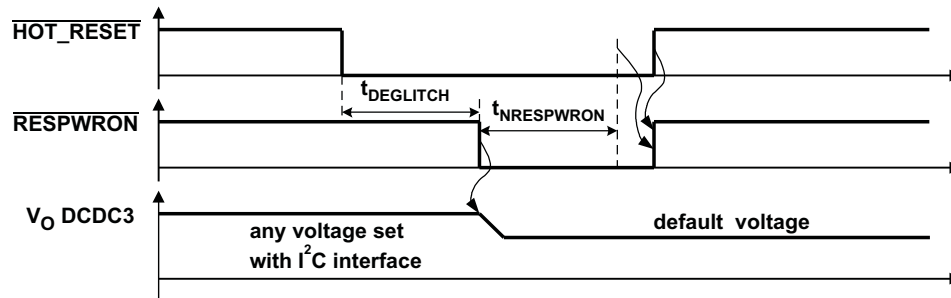
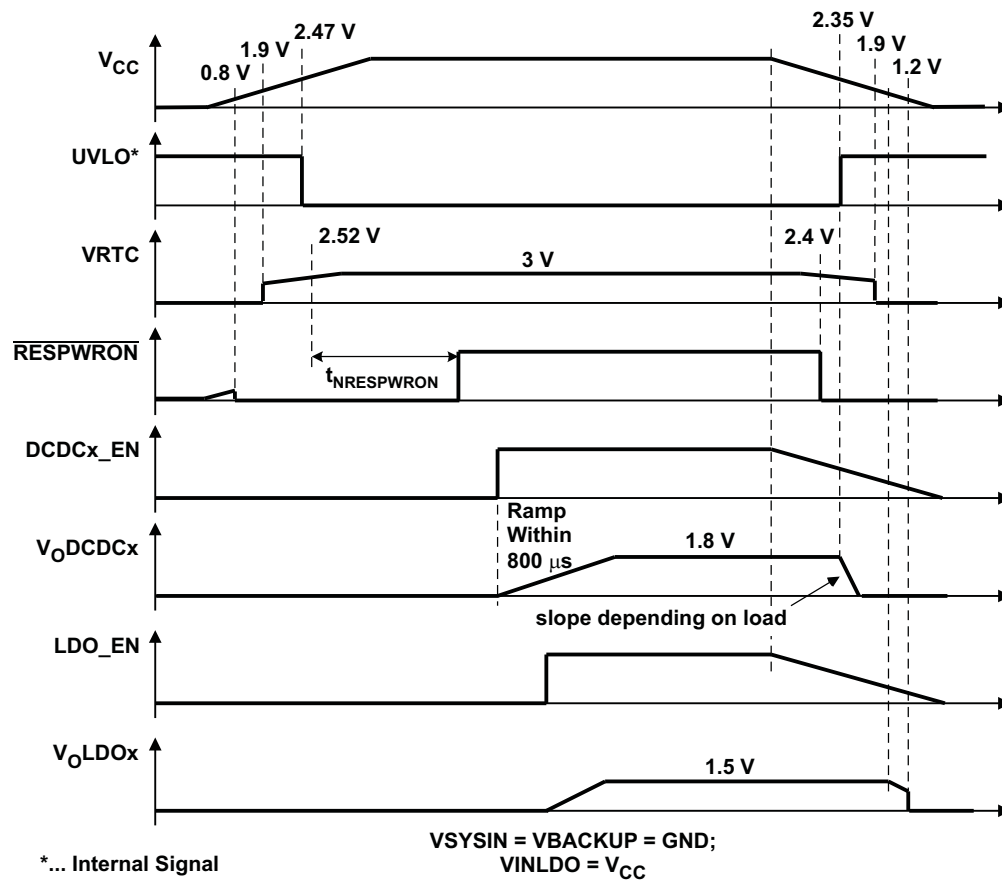
VINDCDC1 = VINDCDC2 = VINDCDC3 = VCC = VINLDO = 3.6 V, VBACKUP = 3 V, T<sub>A</sub> = –40°C to +85°C (unless otherwise noted)

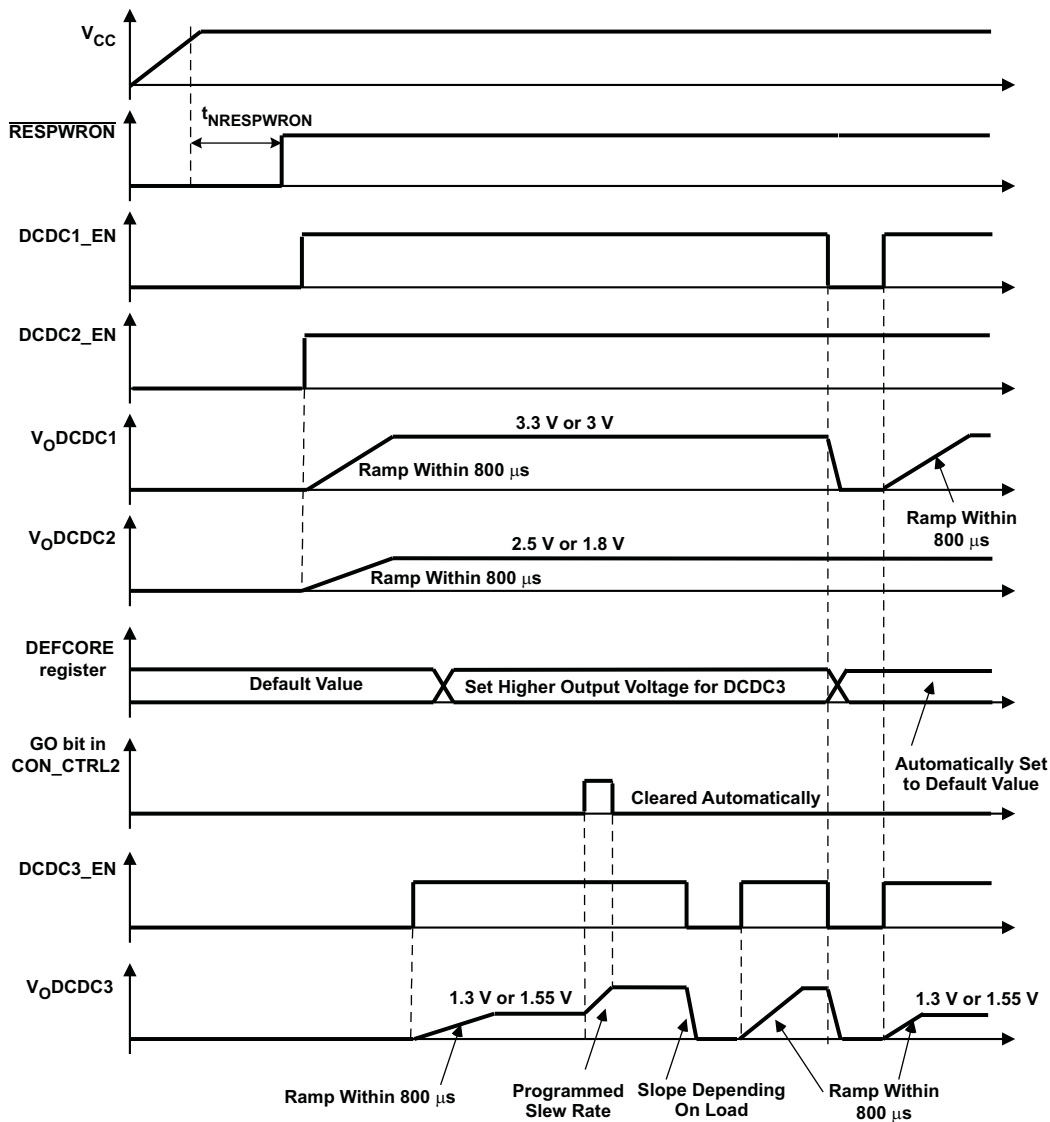
| PARAMETER                          |                                                                         | TEST CONDITIONS                                                               | MIN | TYP <sup>(1)</sup> | MAX | UNIT |
|------------------------------------|-------------------------------------------------------------------------|-------------------------------------------------------------------------------|-----|--------------------|-----|------|
|                                    | Adjustable output voltage with resistor divider at DEFDCDC3 FPMDCDC3=0  | VINDCDC3 = VDCDC3 + 0.5 V (min. 2.5 V) to 6 V; 0 mA ≤ I <sub>O</sub> ≤ 800 mA | –2% |                    | 2%  |      |
|                                    | Adjustable output voltage with resistor divider at DEFDCDC3; FPMDCDC3=1 | VINDCDC3 = VDCDC3 + 0.5 V (min. 2.5 V) to 6 V; 0 mA ≤ I <sub>O</sub> ≤ 800 mA | –1% |                    | 1%  |      |
| Line Regulation                    |                                                                         | VINDCDC3 = VDCDC3 + 0.3 V (min. 2.5 V) to 6 V; I <sub>O</sub> = 10 mA         |     | 0%                 |     | V    |
| Load Regulation                    |                                                                         | I <sub>O</sub> = 10 mA to 400 mA                                              |     | 0.25%              |     | A    |
| Soft-start ramp time               |                                                                         | VDCDC3 ramping from 5% to 95% of target value                                 |     | 750                |     | μs   |
| Internal resistance from L3 to GND |                                                                         |                                                                               |     | 1                  |     | MΩ   |
| VDCDC3 discharge resistance        |                                                                         | DCDC3 discharge =1                                                            |     | 300                |     | Ω    |

## 7.11 Timing Requirements

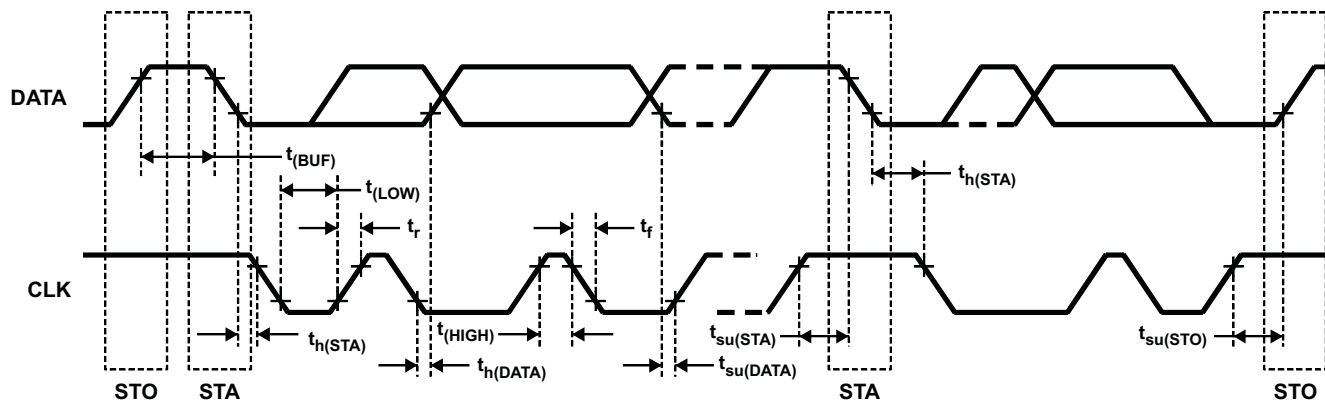
over operating free-air temperature range (unless otherwise noted)

|                       |                                                                                             | MIN  | MAX | UNIT |
|-----------------------|---------------------------------------------------------------------------------------------|------|-----|------|
| f <sub>MAX</sub>      | Clock frequency                                                                             |      | 400 | kHz  |
| t <sub>WH(HIGH)</sub> | Clock high time                                                                             | 600  |     | ns   |
| t <sub>WL(LOW)</sub>  | Clock low time                                                                              | 1300 |     | ns   |
| t <sub>R</sub>        | DATA and CLK rise time                                                                      |      | 300 | ns   |
| t <sub>F</sub>        | DATA and CLK fall time                                                                      |      | 300 | ns   |
| t <sub>h(STA)</sub>   | Hold time (repeated) START condition (after this period the first clock pulse is generated) | 600  |     | ns   |
| t <sub>h(DATA)</sub>  | Setup time for repeated START condition                                                     | 600  |     | ns   |
| t <sub>h(DATA)</sub>  | Data input hold time                                                                        | 300  |     | ns   |
| t <sub>SU(DATA)</sub> | Data input setup time                                                                       | 300  |     | ns   |
| t <sub>SU(STO)</sub>  | STOP condition setup time                                                                   | 600  |     | ns   |
| t <sub>(BUF)</sub>    | Bus free time                                                                               | 1300 |     | ns   |


**Figure 1. HOT\_RESET Timing**

**Figure 2. Power-Up and Power-Down Timing**



**Figure 3. DVS Timing**



**Figure 4. Serial I/F Timing**

## 7.12 Typical Characteristics

Table 1. Table of Graphs

|        |                                   |                   | FIGURE                                                                 |
|--------|-----------------------------------|-------------------|------------------------------------------------------------------------|
| $\eta$ | Efficiency                        | vs Output current | Figure 5, Figure 6, Figure 7, Figure 8, Figure 9, Figure 10, Figure 11 |
|        | Line transient response           |                   | Figure 12, Figure 14, Figure 14                                        |
|        | Load transient response           |                   | Figure 15, Figure 16, Figure 17                                        |
|        | VDCDC2 PFM operation              |                   | Figure 18                                                              |
|        | VDCDC2 low-ripple PFM operation   |                   | Figure 19                                                              |
|        | VDCDC2 PWM operation              |                   | Figure 20                                                              |
|        | Startup VDCDC1, VDCDC2 and VDCDC3 |                   | Figure 21                                                              |
|        | Startup LDO1 and LDO2             |                   | Figure 22                                                              |
|        | Line transient response           |                   | Figure 23, Figure 24, Figure 25                                        |
|        | Load transient response           |                   | Figure 26, Figure 27, Figure 28                                        |

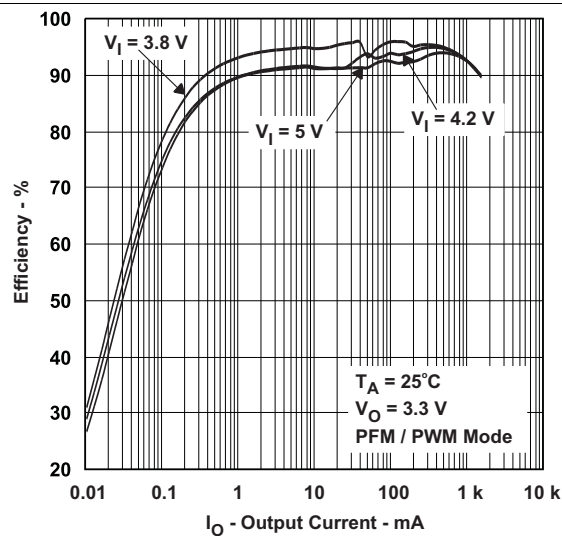


Figure 5. DCDC1: Efficiency vs Output Current

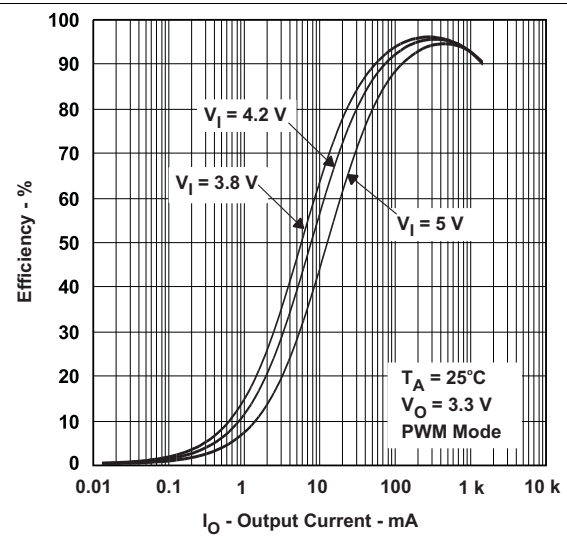


Figure 6. DCDC1: Efficiency vs Output Current

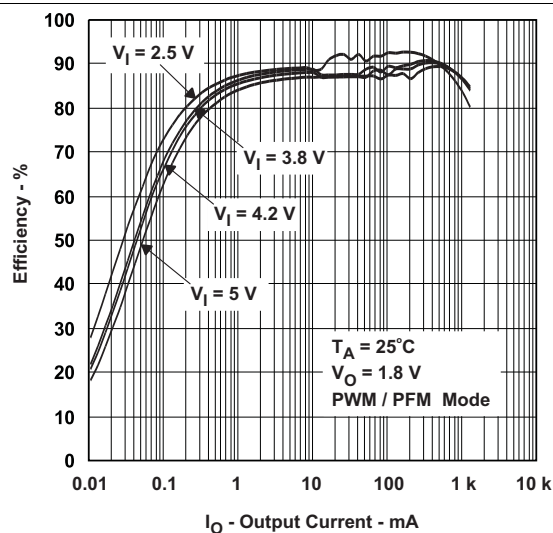


Figure 7. DCDC2: Efficiency vs Output Current

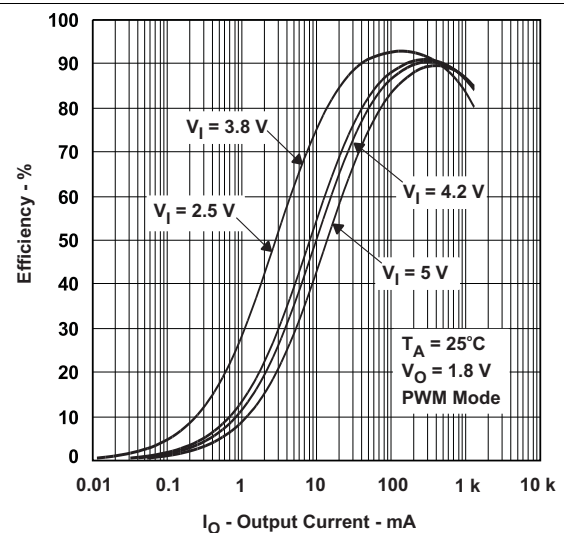


Figure 8. DCDC2: Efficiency vs Output Current

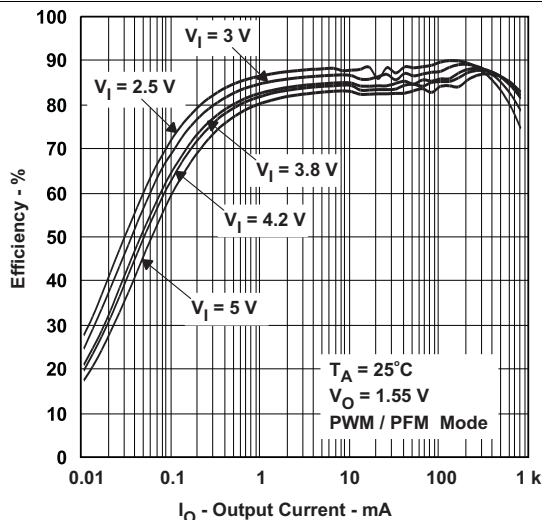


Figure 9. DCDC3: Efficiency vs Output Current

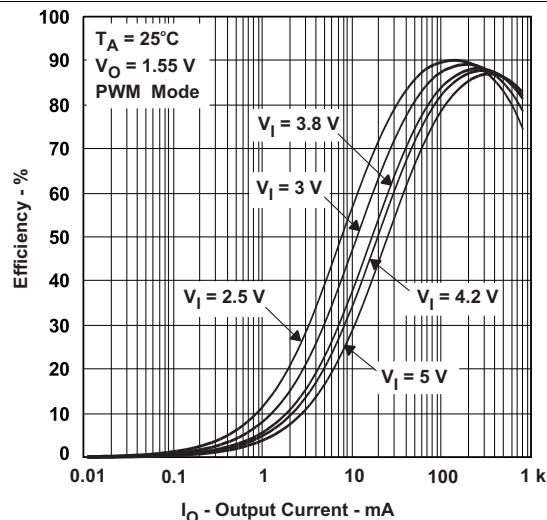


Figure 10. DCDC3: Efficiency vs Output Current

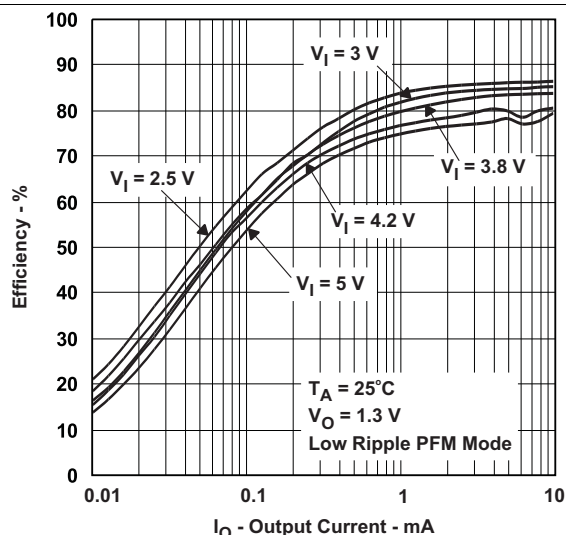


Figure 11. DCDC3: Efficiency vs Output Current

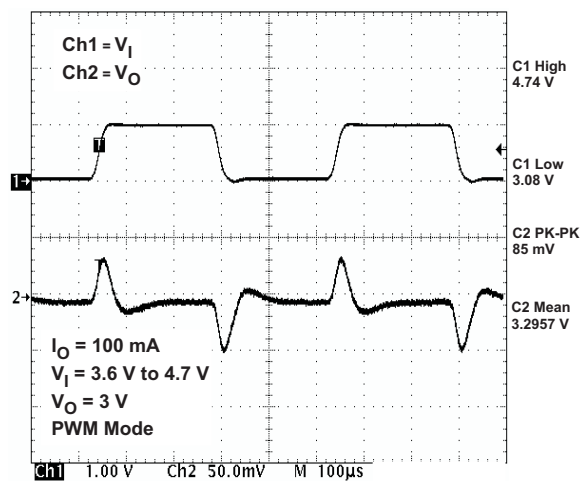


Figure 12. VDCDC1 Line Transient Response

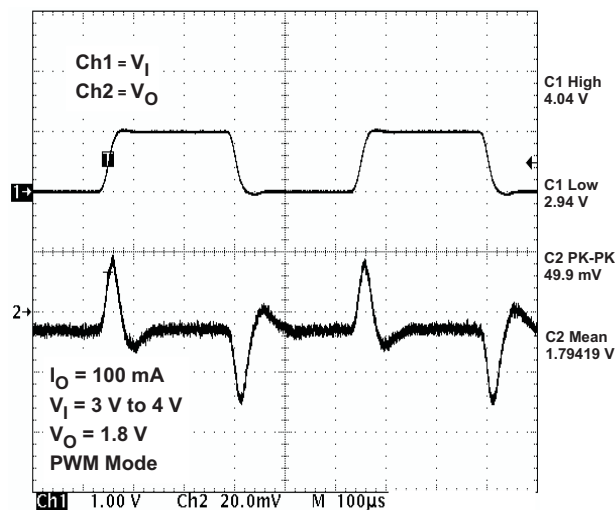


Figure 13. VDCDC2 Line Transient Response

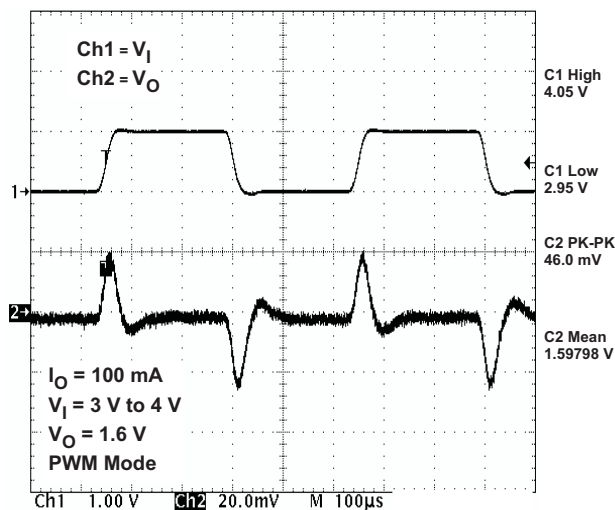


Figure 14. VDCDC3 Line Transient Response

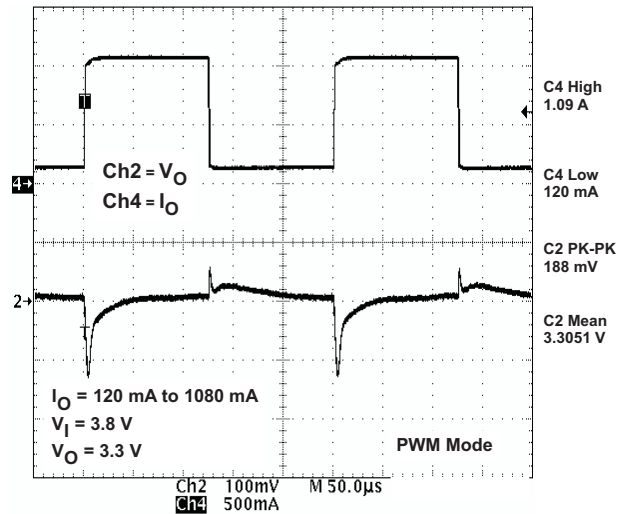


Figure 15. VDCDC1 Load Transient Response

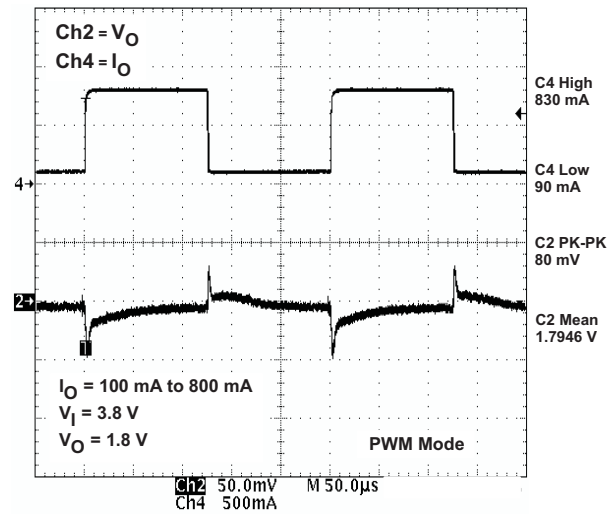


Figure 16. VDCDC2 Load Transient Response

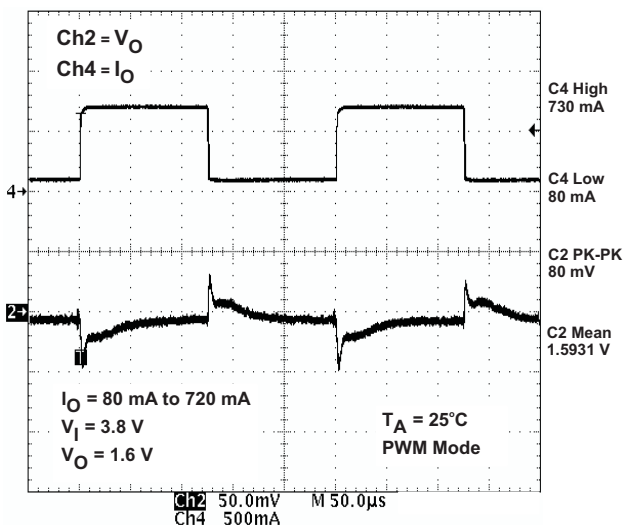


Figure 17. VDCDC3 Load Transient Response

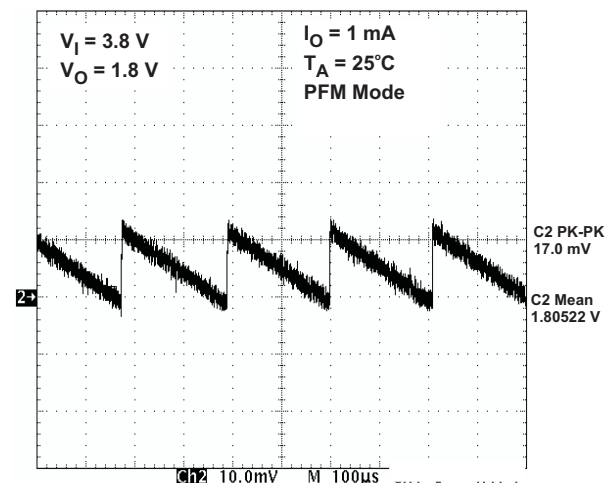


Figure 18. VDCDC2 Output Voltage Ripple

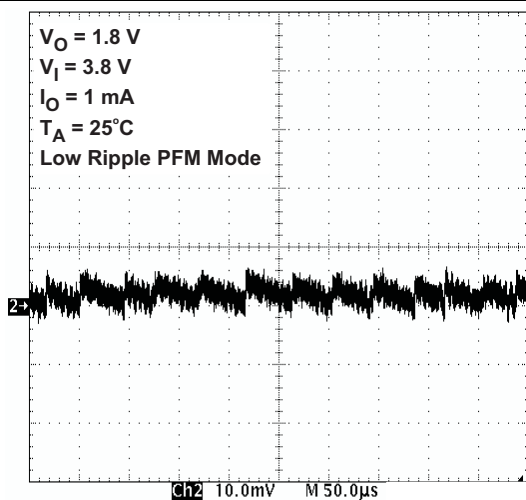


Figure 19. VDCDC2 Output Voltage Ripple

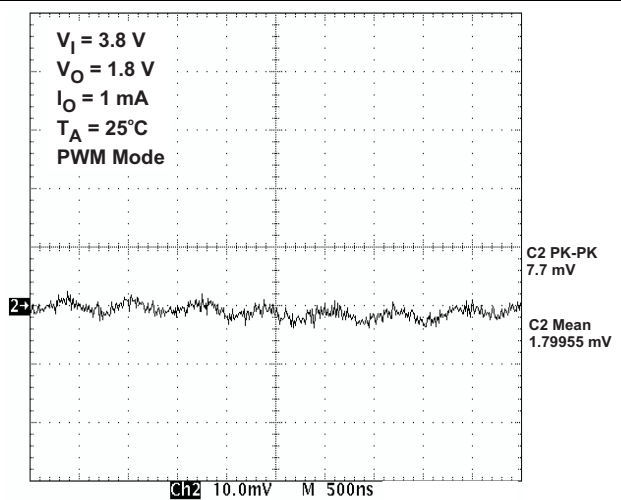


Figure 20. VDCDC2 Output Voltage Ripple

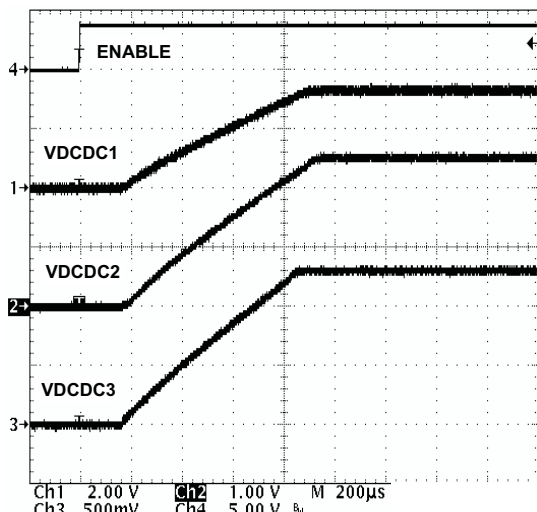


Figure 21. Start-up VDCDC1, VDCDC2, and VDCDC3

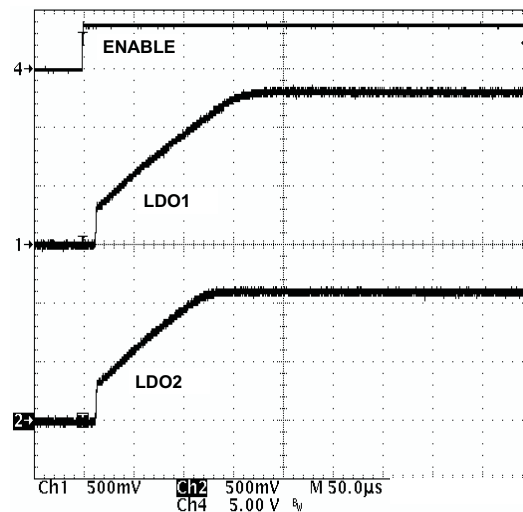


Figure 22. Start-up LDO1 and LDO2

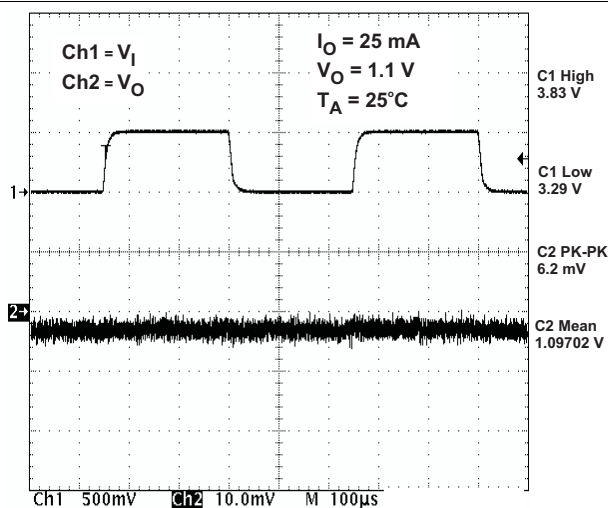


Figure 23. LDO1 Line Transient Response

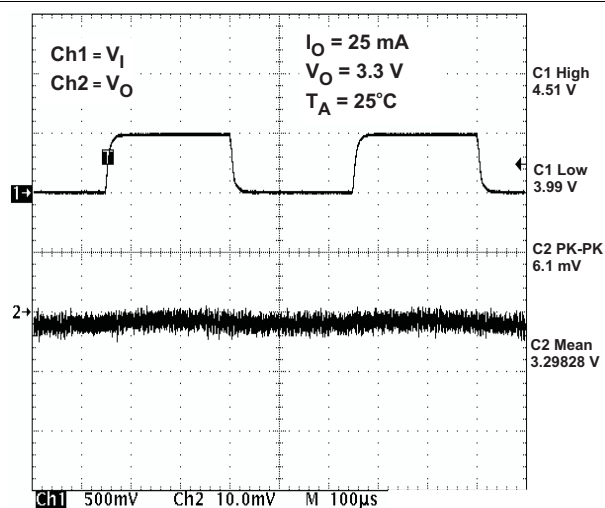


Figure 24. LDO2 Line Transient Response

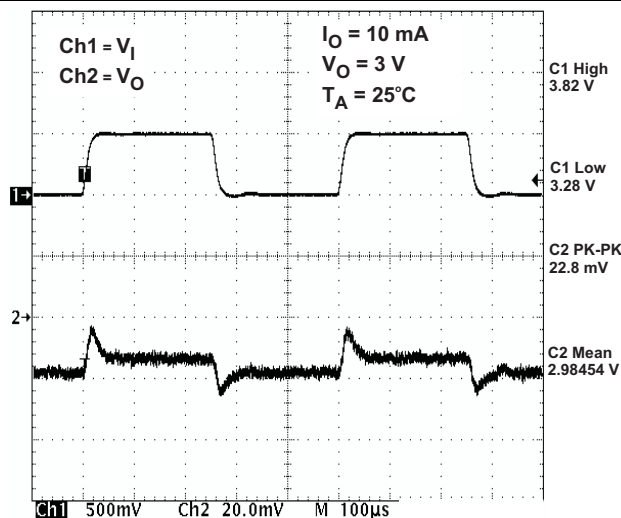


Figure 25. VRTC Line Transient Response

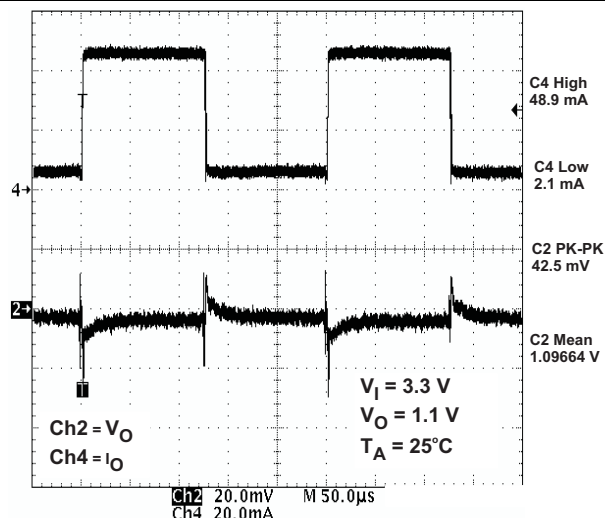


Figure 26. LDO1 Load Transient Response

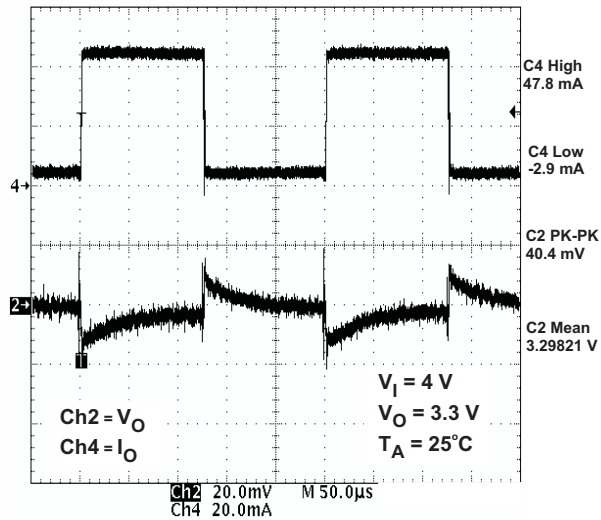


Figure 27. LDO2 Load Transient Response

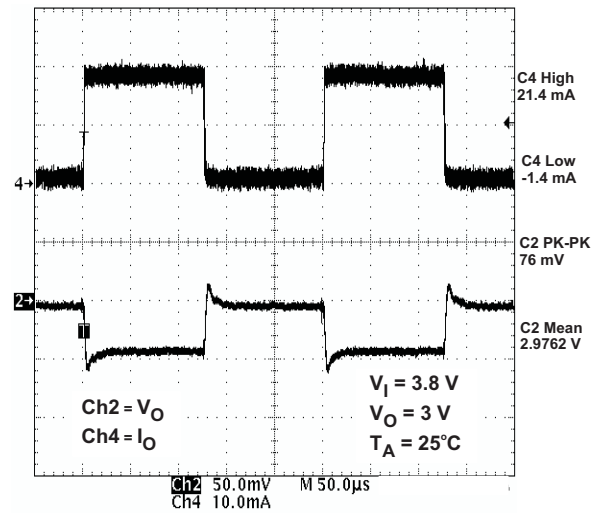


Figure 28. VRTC Load Transient Response

## 8 Detailed Description

### 8.1 Overview

TPS65021 has 5 regulator channels, 3 DCDCs and 2 LDOs. DCDC3 has dynamic voltage scaling feature, DVS, that allows for power reduction to CORE supplies during idle operation or over voltage during heavy-duty operation. With DVS and 2 more DCDCs plus 2 LDOs, the TPS65021 is ideal for CORE, Memory, IO, and peripheral power for the entire system of a wide range of suitable applications.

The device incorporates enables for the DCDCs and LDOs, I<sup>2</sup>C for device control, pushbutton and a reset interface that complete the system and allow for the TPS65021 to be adapted for different kinds of processors or FPGAs.

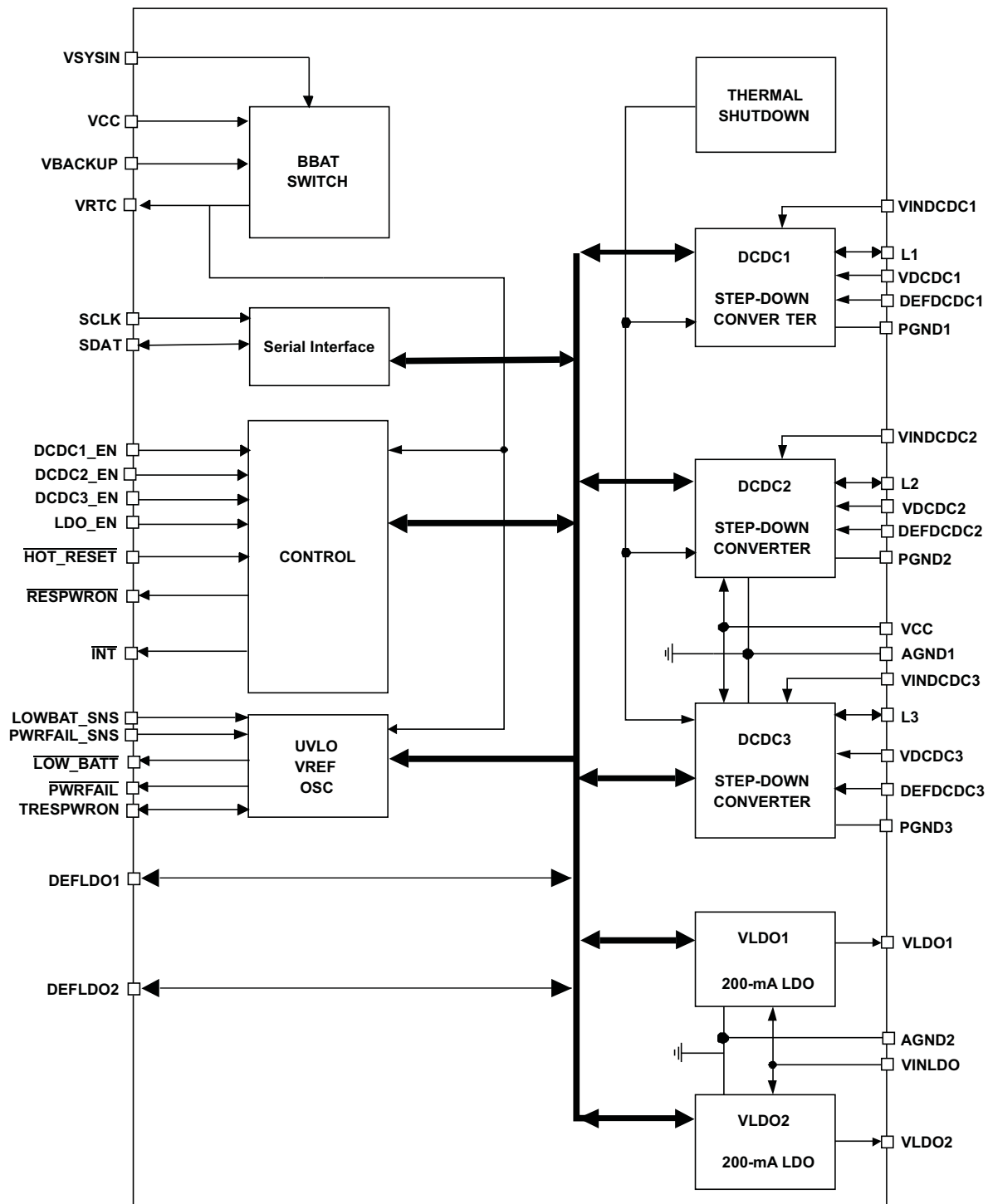
For noise-sensitive circuits, the DCDCs can be synchronized out of phase from one another, reducing the peak noise at the switching frequency. Each converter can be forced to operate in PWM mode to ensure constant switching frequency across the entire load range. However, for low-load efficiency performance the DCDCs automatically enter PSM mode which reduces the switching frequency when the load current is low, saving power at idle operation.

## TPS65021

SLVS613D –OCTOBER 2005–REVISED DECEMBER 2015

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### 8.2 Functional Block Diagram



## 8.3 Feature Description

### 8.3.1 VRTC Output and Operation With or Without Backup Battery

The VRTC pin is an always-on output, intended to supply up to 30 mA to a permanently required rail. This is the VCC\_BATT rail of the Intel PXA270 Bulverde processor for example.

In applications using a backup battery, the backup voltage can be either directly connected to the TPS65021 VBACKUP pin if a Li-Ion cell is used, or through a boost converter (for example, the TPS61070) if a single NiMH battery is used. The voltage applied to the VBACKUP pin is fed through a PMOS switch to the VRTC pin. The TPS65021 asserts the RESPWRON signal if VRTC drops below 2.4 V. This, together with 375 mV at 30-mA drop out for the PMOS switch means that the voltage applied at VBACKUP must be greater than 2.775 V for normal system operation.

When the voltage at the VSYSIN pin exceeds 2.65 V, the path from VBACKUP to VRTC is cut, and VRTC is supplied by a similar PMOS switch from the voltage source connected to the VSYSIN input. Typically this is the VDCDC1 converter but can be any voltage source within the appropriate range.

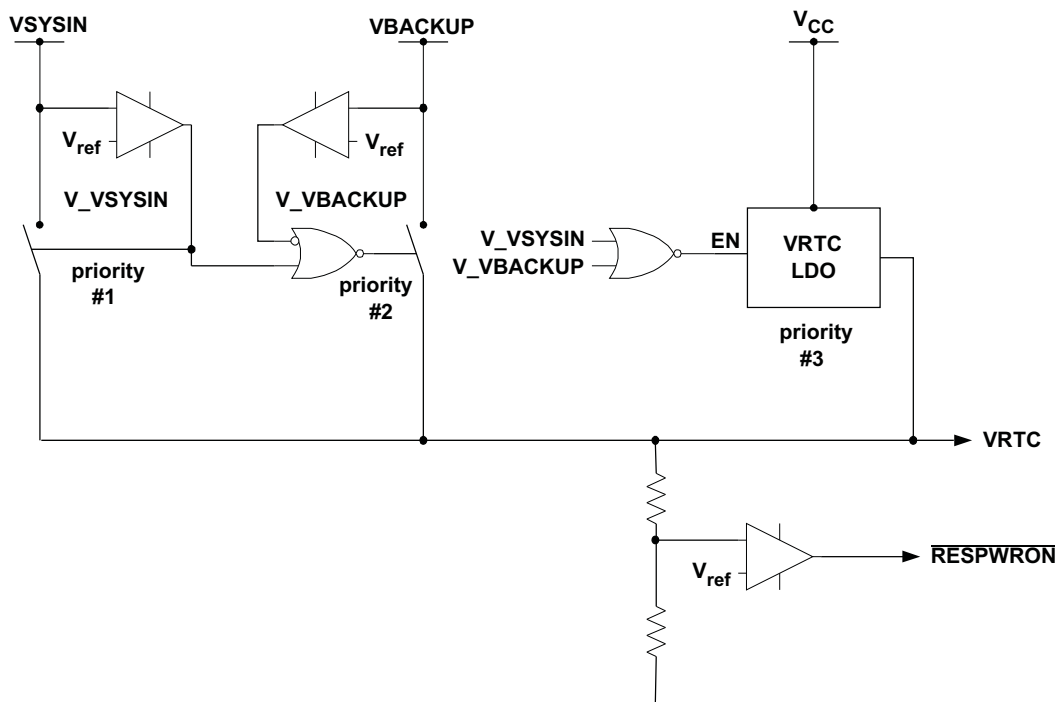
In systems where no backup battery is used, the VBACKUP pin is connected to GND. In this case, a low power LDO is enabled, supplied from VCC and capable of delivering 30 mA to the 3-V output. This LDO is disabled if the voltage at the VSYSIN input exceeds 2.65 V. VRTC is then supplied from the external source connected to this pin as previously described.

Inside TPS65021 there is a switch (Vmax switch) which selects the higher voltage between VCC and VBACKUP. This is used as the supply voltage for some basic functions. The functions powered from the output of the Vmax switch are:

- $\overline{\text{INT}}$  output
- $\overline{\text{RESPWRON}}$  output
- $\overline{\text{HOT\_RESET}}$  input
- $\overline{\text{LOW\_BATT}}$  output
- PWRFAIL output
- Enable pins for DC-DC converters, LDO1 and LDO2
- Undervoltage lockout comparator (UVLO)
- Reference system with low-frequency timing oscillators
- $\overline{\text{LOW\_BATT}}$  and  $\overline{\text{PWRFAIL}}$  comparators

The main 1.5-MHz oscillator, and the I<sup>2</sup>C interface are only powered from V<sub>CC</sub>.

## Feature Description (continued)



- A.  $V\_VSYSIN$ ,  $V\_VBACKUP$  thresholds: falling = 2.55 V, rising = 2.65 V  $\pm 3\%$   
 B.  $RESPWRON$  thresholds: falling = 2.4 V, rising = 2.52 V  $\pm 3\%$

**Figure 29. RTC and  $\overline{RESPWRON}$**

### 8.3.2 Step-Down Converters, VDCDC1, VDCDC2, and VDCDC3

The TPS65021 incorporates three synchronous step-down converters operating typically at 1.5-MHz fixed-frequency pulse width modulation (PWM) at moderate to heavy load currents. At light load currents, the converters automatically enter the power save mode (PSM), and operate with pulse frequency modulation (PFM). The VDCDC1 converter is capable of delivering 1.2-A output current, the VDCDC2 converter is capable of delivering 1 A and the VDCDC3 converter is capable of delivering up to 900 mA.

The converter output voltages can be programmed through the DEFDCDC1, DEFDCDC2, and DEFDCDC3 pins. The pins can either be connected to GND, VCC, or to a resistor divider between the output voltage and GND. The VDCDC1 converter defaults to 3 V or 3.3 V depending on the DEFDCDC1 configuration pin. If DEFDCDC1 is tied to ground, the default is 3 V. If it is tied to VCC, the default is 3.3 V. When the DEFDCDC1 pin is connected to a resistor divider, the output voltage can be set in the range of 0.6 V to VINDCDC1 V. See [Application Information](#) for more details.

The VDCDC2 converter defaults to 1.8 V or 2.5 V depending on the DEFDCDC2 configuration pin. If DEFDCDC2 is tied to ground, the default is 1.8 V. If it is tied to VCC, the default is 2.5 V. When the DEFDCDC2 pin is connected to a resistor divider, the output voltage can be set in the range of 0.6 V to VINDCDC2 V.

The VDCDC3 converter defaults to 1.3 V or 1.55 V depending on the DEFDCDC3 configuration pin. If DEFDCDC3 is tied to ground the default is 1.3 V. If it is tied to VCC, the default is 1.55 V. When the DEFDCDC3 pin is connected to a resistor divider, the output voltage can be set in the range of 0.6 V to VINDCDC3 V. The core voltage can be reprogrammed through the serial interface in the range of 0.8 V to 1.6 V with a programmable slew rate. The converter is forced into PWM operation whilst any programmed voltage change is underway, whether the voltage is being increased or decreased. The DEFCORE and DEFSLEW registers are used to program the output voltage and slew rate during voltage transitions.

The step-down converter outputs (when enabled) are monitored by power-good (PG) comparators, the outputs of which are available through the serial interface. The outputs of the DC-DC converters can be optionally discharged through on-chip 300- $\Omega$  resistors when the DC-DC converters are disabled.

## Feature Description (continued)

During PWM operation, the converters use a unique fast response voltage mode controller scheme with input voltage feedforward to achieve good line and load regulation allowing the use of small ceramic input and output capacitors. At the beginning of each clock cycle initiated by the clock signal, the P-channel MOSFET switch is turned on. The inductor current ramps up until the comparator trips and the control logic turns off the switch. The current limit comparator also turns off the switch if the current limit of the P-channel switch is exceeded. After the adaptive dead-time used to prevent shoot through current, the N-channel MOSFET rectifier is turned on, and the inductor current ramps down. The next cycle is initiated by the clock signal, again turning off the N-channel rectifier and turning on the P-channel switch.

The three DC-DC converters operate synchronized to each other with the VDCDC1 converter as the master. A 180° phase shift between the VDCDC1 switch turn on and the VDCDC2 and a further 90° shift to the VDCDC3 switch turn on decreases the input RMS current and smaller input capacitors can be used. This is optimized for a typical application where the VDCDC1 converter regulates a Li-Ion battery voltage of 3.7 V to 3.3 V, the VDCDC2 converter from 3.7 V to 2.5 V, and the VDCDC3 converter from 3.7 V to 1.5 V. The phase of the three converters can be changed using the CON\_CTRL register.

### 8.3.3 Power Save Mode Operation

As the load current decreases, the converters enter the power save mode operation. During PSM, the converters operate in a burst mode (PFM mode) with a frequency between 750 kHz and 1.5 MHz, nominal for one burst cycle. However, the frequency between different burst cycles depends on the actual load current and is typically far less than the switching frequency with a minimum quiescent current to maintain high efficiency.

To optimize the converter efficiency at light load, the average current is monitored and if in PWM mode the inductor current remains below a certain threshold, then PSM is entered. The typical threshold to enter PSM is calculated with [Equation 1](#), [Equation 2](#), and [Equation 3](#).

$$I_{PFMDCDC1 \text{ enter}} = \frac{V_{INDCDC1}}{24 \, \Omega} \quad (1)$$

$$I_{PFMDCDC2 \text{ enter}} = \frac{V_{INDCDC2}}{26 \, \Omega} \quad (2)$$

$$I_{PFMDCDC3 \text{ enter}} = \frac{V_{INDCDC3}}{39 \, \Omega} \quad (3)$$

During the PSM the output voltage is monitored with a comparator, and by maximum skip burst width. As the output voltage falls below the threshold, set to the nominal  $V_O$ , the P-channel switch turns on and the converter effectively delivers a constant current defined with [Equation 4](#), [Equation 5](#), and [Equation 6](#).

$$I_{PFMDCDC1 \text{ leave}} = \frac{V_{INDCDC1}}{18 \, \Omega} \quad (4)$$

$$I_{PFMDCDC2 \text{ leave}} = \frac{V_{INDCDC2}}{20 \, \Omega} \quad (5)$$

$$I_{PFMDCDC3 \text{ leave}} = \frac{V_{INDCDC3}}{29 \, \Omega} \quad (6)$$

If the load is below the delivered current then the output voltage rises until the same threshold is crossed in the other direction. All switching activity ceases, reducing the quiescent current to a minimum until the output voltage has again dropped below the threshold. The power save mode is exited, and the converter returns to PWM mode if either of the following conditions are met:

1. the output voltage drops 2% below the nominal  $V_O$  due to increasing load current, and
2. the PFM burst time exceeds  $16 \times 1 / f_s$  (10.67  $\mu$ s typical).

These control methods reduce the quiescent current to typically 14  $\mu$ A per converter, and the switching activity to a minimum, thus achieving the highest converter efficiency. Setting the comparator thresholds at the nominal output voltage at light load current results in a low output voltage ripple. The ripple depends on the comparator delay and the size of the output capacitor. Increasing capacitor values makes the output ripple tend to zero. The PSM is disabled through the I<sup>2</sup>C interface to force the individual converters to stay in fixed-frequency PWM mode.

## Feature Description (continued)

### 8.3.4 Low-Ripple Mode

Setting bit 3 in register CON\_CTRL to 1 enables the low-ripple mode for all of the DC-DC converters if operated in PFM mode. For an output current less than approximately 10 mA, the output voltage ripple in PFM mode is reduced, depending on the actual load current. The lower the actual output current on the converter, the lower the output ripple voltage. For an output current above 10 mA, there is only minor difference in output voltage ripple between PFM mode and low-ripple PFM mode. As this feature also increases switching frequency, it is used to keep the switching frequency above the audible range in PFM mode down to a low output current.

### 8.3.5 Soft-Start

Each of the three converters has an internal soft-start circuit that limits the inrush current during start-up. The soft-start is realized by using a very low current to initially charge the internal compensation capacitor. The soft-start time is typically 750  $\mu$ s if the output voltage ramps from 5% to 95% of the final target value. If the output is already precharged to some voltage when the converter is enabled, then this time is reduced proportionally. There is a short delay of typically 170  $\mu$ s between the converter being enabled and switching activity actually starting. This is to allow the converter to bias itself properly, to recognize if the output is precharged, and if so to prevent discharging of the output while the internal soft-start ramp catches up with the output voltage.

### 8.3.6 100% Duty Cycle Low-Dropout Operation

The TPS65021 converters offer a low input to output voltage difference while still maintaining operation with the use of the 100% duty cycle mode. In this mode the P-channel switch is constantly turned on. This is particularly useful in battery-powered applications to achieve longest operation time by taking full advantage of the whole battery voltage range. The minimum input voltage required to maintain DC regulation depends on the load current and output voltage. It is calculated in [Equation 7](#).

$$V_{in\_min} = V_{out\_min} + I_{out\_max} \times (r_{DS(on)}^{max} + R_L)$$

where

- $I_{out\_max}$  = maximum load current (Note: ripple current in the inductor is zero under these conditions)
- $r_{DS(on)}^{max}$  = maximum P-channel switch  $r_{DS(on)}$
- $R_L$  = DC resistance of the inductor
- $V_{out\_min}$  = nominal output voltage minus 2% tolerance limit

(7)

### 8.3.7 Active Discharge When Disabled

When the VDCDC1, VDCDC2, and VDCDC3 converters are disabled, due to an UVLO, DCDC\_EN, or OVERTEMP condition, it is possible to actively pull down the outputs. This feature is disabled per default and is individually enabled through the CON\_CTRL2 register in the serial interface. When this feature is enabled, the VDCDC1, VDCDC2, and VDCDC3 outputs are discharged by a 300- $\Omega$  (typical) load which is active as long as the converters are disabled.

### 8.3.8 Power-Good Monitoring

All three step-down converters and both the LDO1 and LDO2 linear regulators have power-good comparators. Each comparator indicates when the relevant output voltage has dropped 10% below its target value with 5% hysteresis. The outputs of these comparators are available in the PGOODZ register through the serial interface. An interrupt is generated when any voltage rail drops below the 10% threshold. The comparators are disabled when the converters are disabled and the relevant PGOODZ register bits indicate that power is good.

## Feature Description (continued)

### 8.3.9 Low-Dropout Voltage Regulators

The low-dropout voltage regulators are designed to operate well with low value ceramic input and output capacitors. They operate with input voltages down to 1.5 V. The LDOs offer a maximum dropout voltage of 300 mV at rated output current. Each LDO supports a current limit feature. Both LDOs are enabled by the LDO\_EN pin, both LDOs can be disabled or programmed through the serial interface using the REG\_CTRL and LDO\_CTRL registers. The LDOs also have reverse conduction prevention. This allows the possibility to connect external regulators in parallel in systems with a backup battery. The TPS65021 step-down and LDO voltage regulators automatically power down when the  $V_{CC}$  voltage drops below the UVLO threshold or when the junction temperature rises above 160°C.

### 8.3.10 Undervoltage Lockout

The undervoltage lockout circuit for the five regulators on the TPS65021 prevents the device from malfunctioning at low-input voltages and from excessive discharge of the battery. It disables the converters and LDOs. The UVLO circuit monitors the VCC pin, the threshold is set internally to 2.35 V with 5% (120 mV) hysteresis. Consider this current if an external RC filter is used at the VCC pin to remove switching noise from the TPS65021 internal analog circuitry supply.

#### NOTE

When any of the DC-DC converters are running, there is an input current at the VCC pin, which is up to 3 mA when all three converters are running in PWM mode.

### 8.3.11 Power-Up Sequencing

The TPS65021 power-up sequencing is designed to be entirely flexible and customer driven. This is achieved by providing separate enable pins for each switch-mode converter, and a common enable signal for the LDOs. The relevant control pins are described in [Table 2](#).

**Table 2. Control Pins and Status Outputs for DC-DC Converters**

| PIN NAME                       | INPUT OR OUTPUT | FUNCTION                                                                                                                                                                                                                                                                                                                                                                                                                |
|--------------------------------|-----------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| DEFDCDC3                       | I               | Defines the default voltage of the VDCDC3 switching converter. DEFDCDC3 = 0 defaults VDCDC3 to 1.3 V, DEFDCDC3 = VCC defaults VDCDC3 to 1.55 V.                                                                                                                                                                                                                                                                         |
| DEFDCDC2                       | I               | Defines the default voltage of the VDCDC2 switching converter. DEFDCDC2 = 0 defaults VDCDC2 to 1.8 V, DEFDCDC2 = VCC defaults VDCDC2 to 2.5 V.                                                                                                                                                                                                                                                                          |
| DEFDCDC1                       | I               | Defines the default voltage of the VDCDC1 switching converter. DEFDCDC1 = 0 defaults VDCDC1 to 3 V, DEFDCDC1 = VCC defaults VDCDC1 to 3.3 V.                                                                                                                                                                                                                                                                            |
| DCDC3_EN                       | I               | Set DCDC3_EN = 0 to disable and DCDC3_EN = 1 to enable the VDCDC3 converter.                                                                                                                                                                                                                                                                                                                                            |
| DCDC2_EN                       | I               | Set DCDC2_EN = 0 to disable and DCDC2_EN = 1 to enable the VDCDC2 converter.                                                                                                                                                                                                                                                                                                                                            |
| DCDC1_EN                       | I               | Set DCDC1_EN = 0 to disable and DCDC1_EN = 1 to enable the VDCDC1 converter.                                                                                                                                                                                                                                                                                                                                            |
| $\overline{\text{HOT\_RESET}}$ | I               | The $\overline{\text{HOT\_RESET}}$ pin generates a reset ( $\overline{\text{RESPWRON}}$ ) for the processor. $\overline{\text{HOT\_RESET}}$ does not alter any TPS65021 settings except the output voltage of VDCDC3. Activating $\overline{\text{HOT\_RESET}}$ sets the voltage of VDCDC3 to its default value defined with the DEFDCDC3 pin. $\overline{\text{HOT\_RESET}}$ is internally de-bounced by the TPS65021. |
| $\overline{\text{RESPWRON}}$   | O               | $\overline{\text{RESPWRON}}$ is held low when power is initially applied to the TPS65021. The VRTC voltage is monitored: $\overline{\text{RESPWRON}}$ is low when $\text{VRTC} < 2.4 \text{ V}$ and remains low for a time defined by the external capacitor at the TRESPWRON pin. $\overline{\text{RESPWRON}}$ can also be forced low by activation of the $\overline{\text{HOT\_RESET}}$ pin.                         |
| TRESPWRON                      | I               | Connect a capacitor here to define the RESET time at the $\overline{\text{RESPWRON}}$ pin. 1 nF typically gives 100 ms.                                                                                                                                                                                                                                                                                                 |

## 8.4 Device Functional Modes

The TPS6502x devices are either in the ON or the OFF mode. The OFF mode is entered when the voltage on VCC is below the UVLO threshold, 2.35 V (typically). Once the voltage at VCC has increased above UVLO, the device enters ON mode. In the ON mode, the DCDCs and LDOs are available for use.

## 8.5 Programming

### 8.5.1 System Reset + Control Signals

The  $\overline{\text{RESPWRON}}$  signal can be used as a global reset for the application. It is an open-drain output. The  $\overline{\text{RESPWRON}}$  signal is generated according to the power-good comparator of VRTC, and remains low for  $t_{\text{nrespwrn}}$  seconds after VRTC has risen above 2.52 V (falling threshold is 2.4 V, 5% hysteresis).  $t_{\text{nrespwrn}}$  is set by an external capacitor at the TRESPWRON pin. 1 nF gives typically 100 ms.  $\overline{\text{RESPWRON}}$  is also triggered by the  $\overline{\text{HOT\_RESET}}$  input. This input is internally debounced, with a filter time of typically 30 ms.

The  $\overline{\text{PWRFAIL}}$  and  $\overline{\text{LOW\_BAT}}$  signals are generated by two voltage detectors using the PWRFAIL\_SNS and LOWBAT\_SNS input signals. Each input signal is compared to a 1-V threshold (falling edge) with 5% (50 mV) hysteresis.

The DCDC3 converter is reset to its default output voltage defined by the DEFDCDC3 input, when  $\overline{\text{HOT\_RESET}}$  is asserted. Other I<sup>2</sup>C registers are not affected. Generally, the DCDC3 converter is set to its default voltage with one of these conditions:  $\overline{\text{HOT\_RESET}}$  active, VRTC lower than its threshold voltage, undervoltage lockout (UVLO) condition,  $\overline{\text{RESPWRON}}$  active, both DCDC3-converter AND DCDC1-converter disabled. In addition, the voltage of VDCDC3 changes to 1xxx0, if the VDCDC1 converter is disabled. Where xxx is the state before VDCDC1 was disabled.

#### 8.5.1.1 DEFLDO1 and DEFLDO2

These two pins are used to set the default output voltage of the two 200-mA LDOs. The digital value applied to the pins is latched during power up and determines the initial output voltage according to Table 3. The voltage of both LDOs can be changed during operation with the I<sup>2</sup>C interface as described in the interface description.

**Table 3. LDO1 and LDO2 Default Voltage Options**

| DEFLDO2 | DEFLDO1 | VLDO1  | VLDO2 |
|---------|---------|--------|-------|
| 0       | 0       | 1.1 V  | 1.3 V |
| 0       | 1       | 1.5 V  | 1.3 V |
| 1       | 0       | 2.6 V  | 2.8 V |
| 1       | 1       | 3.15 V | 3.3 V |

#### 8.5.1.2 Interrupt Management and the $\overline{\text{INT}}$ Pin

The  $\overline{\text{INT}}$  pin combines the outputs of the PGOOD comparators from each DC-DC converter and LDOs. The  $\overline{\text{INT}}$  pin is used as a POWER\_OK pin indicating when all enabled supplies are in regulation. If the PGOODZ register is read through the serial interface, any active bits are then blocked from the  $\overline{\text{INT}}$  output pin.

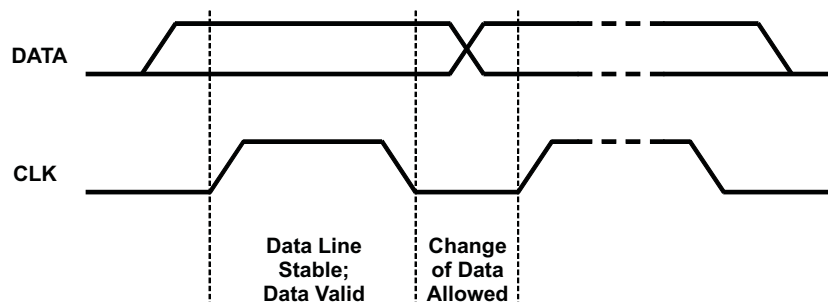
Interrupts can be masked using the MASK register; default operation is not to mask any DCDC or LDO interrupts because this provides the POWER\_OK function.

### 8.5.2 Serial Interface

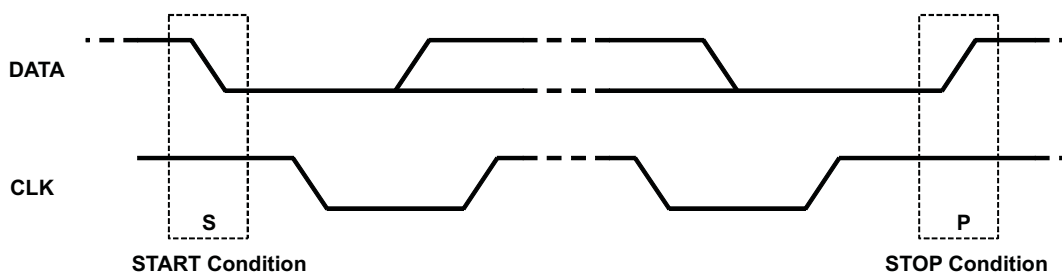
The serial interface is compatible with the standard and fast mode I<sup>2</sup>C specifications, allowing transfers at up to 400 kHz. The interface adds flexibility to the power supply solution, enabling most functions to be programmed to new values depending on the instantaneous application requirements and charger status to be monitored. Register contents remain intact as long as VCC remains above 2 V. The TPS65021 has a 7-bit address: 1001000, other addresses are available upon contact with the factory. Attempting to read data from the register addresses not listed in this section results in FFh being read out.

For normal data transfer, DATA is allowed to change only when CLK is low. Changes when CLK is high are reserved for indicating the start and stop conditions. During data transfer, the data line must remain stable whenever the clock line is high. There is one clock pulse per bit of data. Each data transfer is initiated with a start condition and terminated with a stop condition. When addressed, the TPS65021 device generates an acknowledge bit after the reception of each byte. The master device (microprocessor) must generate an extra clock pulse that is associated with the acknowledge bit. The TPS65021 device must pull down the DATA line during the acknowledge clock pulse so that the DATA line is a stable low during the high period of the

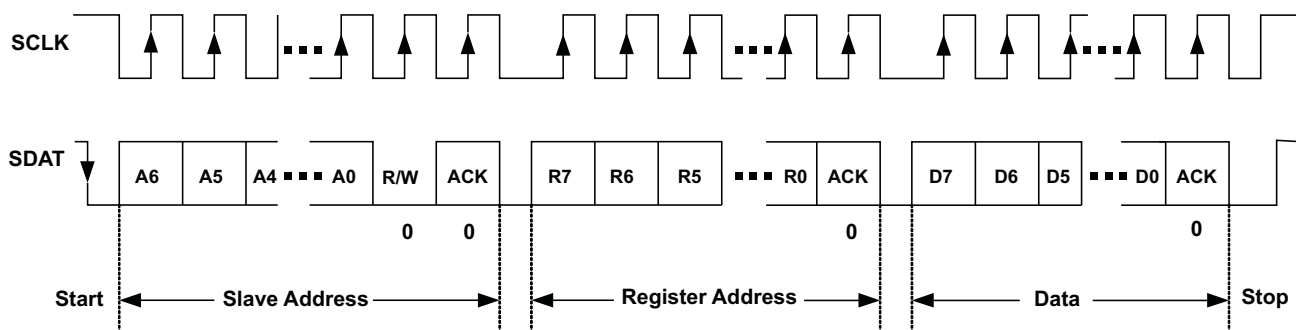
acknowledge clock pulse. The DATA line is a stable low during the high period of the acknowledge-related clock pulse. Setup and hold times must be taken into account. During read operations, a master must signal the end of data to the slave by not generating an acknowledge bit on the last byte that was clocked out of the slave. In this case, the slave TPS65021 device must leave the data line high to enable the master to generate the stop condition



**Figure 30. Bit Transfer on the Serial Interface**



**Figure 31. START and STOP Conditions**

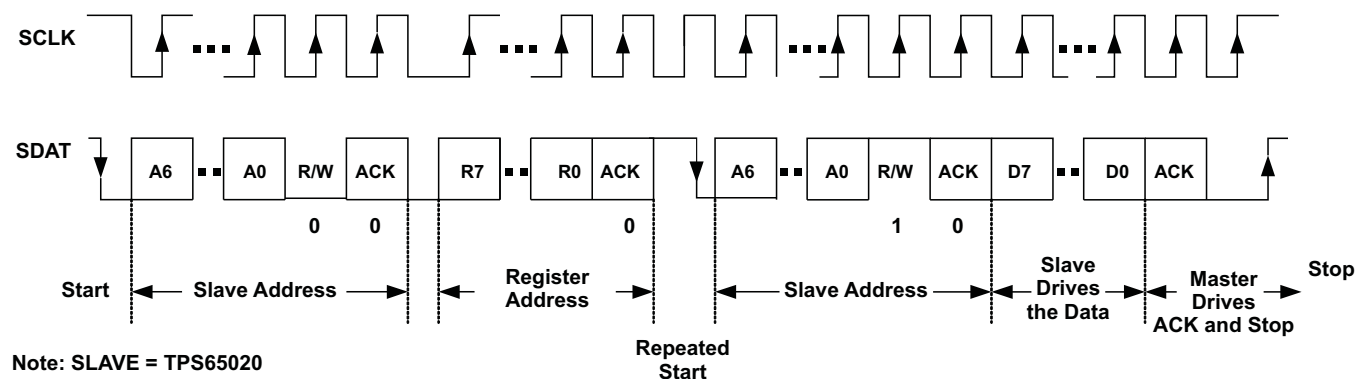
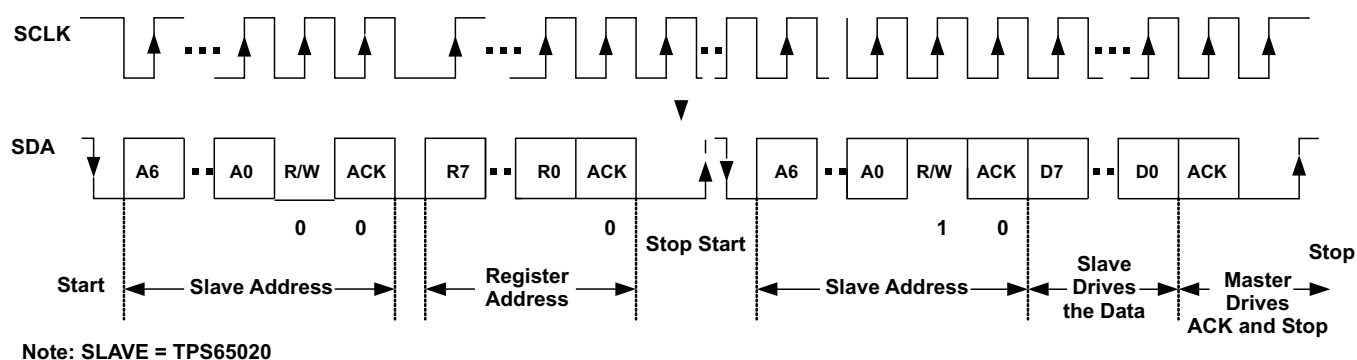


**Note:** SLAVE = TPS65020

**Figure 32. Serial I/F WRITE to TPS65021 Device**

**TPS65021**

SLVS613D –OCTOBER 2005–REVISED DECEMBER 2015

[www.ti.com](http://www.ti.com)

**Figure 33. Serial I/F READ from TPS65021: Protocol A**

**Figure 34. Serial I/F READ from TPS65021: Protocol B**

## 8.6 Register Maps

### 8.6.1 VERSION Register Address: 00h (Read Only)

**Table 4. VERSION Register**

| VERSION               | B7 | B6 | B5 | B4 | B3 | B2 | B1 | B0 |
|-----------------------|----|----|----|----|----|----|----|----|
| Bit name and function | 0  | 0  | 1  | 0  | 0  | 0  | 0  | 1  |
| Read/write            | R  | R  | R  | R  | R  | R  | R  | R  |

### 8.6.2 PGOODZ Register Address: 01h (Read Only)

**Table 5. PGOODZ Register**

| PGOODZ                | B7       | B6       | B5            | B4            | B3            | B2          | B1          | B0 |
|-----------------------|----------|----------|---------------|---------------|---------------|-------------|-------------|----|
| Bit name and function | PWRFAILZ | LOWBATTZ | PGOODZ VDCDC1 | PGOODZ VDCDC2 | PGOODZ VDCDC3 | PGOODZ LDO2 | PGOODZ LDO1 | –  |
| Set by signal         | PWRFAIL  | LOWBATT  | PGOODZ VDCDC1 | PGOODZ VDCDC2 | PGOODZ VDCDC3 | PGOODZ LDO2 | PGOODZ LDO1 | –  |
| Default value loaded  | PWRFAILZ | LOWBATTZ | PGOOD VDCDC1  | PGOOD VDCDC2  | PGOOD VDCDC3  | PGOOD LDO2  | PGOOD LDO1  | –  |
| Read/write            | R        | R        | R             | R             | R             | R           | R           | R  |

Bit 7 PWRFAILZ:

0 = indicates that the PWRFAIL\_SNS input voltage is above the 1-V threshold.

1 = indicates that the PWRFAIL\_SNS input voltage is below the 1-V threshold.

Bit 6 LOWBATTZ:

0 = indicates that the LOWBATT\_SNS input voltage is above the 1-V threshold.

1 = indicates that the LOWBATT\_SNS input voltage is below the 1-V threshold.

Bit 5 PGOODZ VDCDC1:

0 = indicates that the VDCDC1 converter output voltage is within its nominal range. This bit is zero if the VDCDC1 converter is disabled.

1 = indicates that the VDCDC1 converter output voltage is below its target regulation voltage

Bit 4 PGOODZ VDCDC2:

0 = indicates that the VDCDC2 converter output voltage is within its nominal range. This bit is zero if the VDCDC2 converter is disabled.

1 = indicates that the VDCDC2 converter output voltage is below its target regulation voltage

Bit 3 PGOODZ VDCDC3:

0 = indicates that the VDCDC3 converter output voltage is within its nominal range. This bit is zero if the VDCDC3 converter is disabled and during a DVM controlled output voltage transition

1 = indicates that the VDCDC3 converter output voltage is below its target regulation voltage

Bit 2 PGOODZ LDO2:

0 = indicates that the LDO2 output voltage is within its nominal range. This bit is zero if LDO2 is disabled.

1 = indicates that LDO2 output voltage is below its target regulation voltage

Bit 1 PGOODZ LDO1:

0 = indicates that the LDO1 output voltage is within its nominal range. This bit is zero if LDO1 is disabled.

1 = indicates that the LDO1 output voltage is below its target regulation voltage

### 8.6.3 MASK Register Address: 02h (Read and Write), Default Value: C0h

**Table 6. MASK Register**

| MASK                  | B7            | B6            | B5          | B4          | B3          | B2        | B1        | B0 |
|-----------------------|---------------|---------------|-------------|-------------|-------------|-----------|-----------|----|
| Bit name and function | MASK PWRFAILZ | MASK LOWBATTZ | MASK VDCDC1 | MASK VDCDC2 | MASK VDCDC3 | MASK LDO2 | MASK LDO1 | –  |
| Default               | 1             | 1             | 0           | 0           | 0           | 0         | 0         | 0  |
| Default value loaded  | UVLO          | UVLO          | UVLO        | UVLO        | UVLO        | UVLO      | UVLO      | –  |
| Read/write            | R/W           | R/W           | R/W         | R/W         | R/W         | R/W       | R/W       | –  |

The MASK register can be used to mask particular fault conditions from appearing at the  $\overline{\text{INT}}$  pin. MASK<n> = 1 masks PGOODZ<n>.

### 8.6.4 REG\_CTRL Register Address: 03h (Read and Write), Default Value: FFh

The REG\_CTRL register is used to disable or enable the power supplies through the serial interface. The contents of the register are logically AND'd with the enable pins to determine the state of the supplies. A UVLO condition resets the REG\_CTRL to 0xFF, so the state of the supplies defaults to the state of the enable pin. The REG\_CTRL bits are automatically reset to default when the corresponding enable pin is low.

**Table 7. REG\_CTRL Register**

| REG_CTRL              | B7 | B6 | B5            | B4            | B3            | B2          | B1          | B0 |
|-----------------------|----|----|---------------|---------------|---------------|-------------|-------------|----|
| Bit name and function | –  | –  | VDCDC1 ENABLE | VDCDC2 ENABLE | VDCDC3 ENABLE | LDO2 ENABLE | LDO1 ENABLE | –  |
| Default               | 1  | 1  | 1             | 1             | 1             | 1           | 1           | 1  |
| Set by signal         | –  | –  | DCDC1_ENZ     | DCDC2_ENZ     | DCDC3_ENZ     | LDO_ENZ     | LDO_ENZ     | –  |
| Default value loaded  | –  | –  | UVLO          | UVLO          | UVLO          | UVLO        | UVLO        | –  |
| Read/write            | –  | –  | R/W           | R/W           | R/W           | R/W         | R/W         | –  |

#### Bit 5 VDCDC1 ENABLE:

DCDC1 Enable. This bit is logically AND'd with the state of the DCDC1\_EN pin to turn on the DCDC1 converter. Reset to 1 by a UVLO condition, the bit can be written to 0 or 1 through the serial interface. The bit is reset to 1 when the pin DCDC1\_EN is pulled to GND, allowing DCDC1 to turn on when DCDC1\_EN returns high.

#### Bit 4 VDCDC2 ENABLE:

DCDC2 Enable. This bit is logically AND'd with the state of the DCDC2\_EN pin to turn on the DCDC2 converter. Reset to 1 by a UVLO condition, the bit can be written to 0 or 1 through the serial interface. The bit is reset to 1 when the pin DCDC2\_EN is pulled to GND, allowing DCDC2 to turn on when DCDC2\_EN returns high.

#### Bit 3 VDCDC3 ENABLE:

DCDC3 Enable. This bit is logically AND'd with the state of the DCDC3\_EN pin to turn on the DCDC3 converter. Reset to 1 by a UVLO condition, the bit can be written to 0 or 1 through the serial interface. The bit is reset to 1 when the pin DCDC3\_EN is pulled to GND, allowing DCDC3 to turn on when DCDC3\_EN returns high.

#### Bit 2 LDO2 ENABLE:

LDO2 Enable. This bit is logically AND'd with the state of the LDO2\_EN pin to turn on LDO2. Reset to 1 by a UVLO condition, the bit can be written to 0 or 1 the serial interface. The bit is reset to 1 when the pin LDO\_EN is pulled to GND, allowing LDO2 to turn on when LDO\_EN returns high.

#### Bit 1 LDO1 ENABLE:

LDO1 Enable. This bit is logically AND'ed with the state of the LDO1\_EN pin to turn on LDO1. Reset to 1 by a UVLO condition, the bit can be written to 0 or 1 through the serial interface. The bit is reset to 1 when the pin LDO\_EN is pulled to GND, allowing LDO1 to turn on when LDO\_EN returns high.

### 8.6.5 CON\_CTRL Register Address: 04h (Read and Write), Default Value: B1h

**Table 8. CON\_CTRL Register**

| CON_CTRL              | B7           | B6           | B5           | B4           | B3         | B2         | B1         | B0         |
|-----------------------|--------------|--------------|--------------|--------------|------------|------------|------------|------------|
| Bit name and function | DCDC2 PHASE1 | DCDC2 PHASE0 | DCDC3 PHASE1 | DCDC3 PHASE0 | LOW RIPPLE | FPWM DCDC2 | FPWM DCDC1 | FPWM DCDC3 |
| Default               | 1            | 0            | 1            | 1            | 0          | 0          | 0          | 1          |
| Default value loaded  | UVLO         | UVLO         | UVLO         | UVLO         | UVLO       | UVLO       | UVLO       | UVLO       |
| Read/write            | R/W          | R/W          | R/W          | R/W          | R/W        | R/W        | R/W        | R/W        |

The CON\_CTRL register is used to force any or all of the converters into forced PWM operation, when low output voltage ripple is vital. It is also used to control the phase shift between the three converters to minimize the input rms current, hence reduce the required input blocking capacitance. The DCDC1 converter is taken as the reference and consequently has a fixed zero phase shift.

**Table 9. DCDC2 and DCDC3 Phase Delay**

| CON_CTRL<7:6> | DCDC2 CONVERTER DELAYED BY |  | CON_CTRL<5:4> | DCDC3 CONVERTER DELAYED BY |
|---------------|----------------------------|--|---------------|----------------------------|
| 00            | zero                       |  | 00            | zero                       |
| 01            | 1/4 cycle                  |  | 01            | 1/4 cycle                  |
| 10            | 1/2 cycle                  |  | 10            | 1/2 cycle                  |
| 11            | 3/4 cycle                  |  | 11            | 3/4 cycle                  |

**Bit 3 LOW RIPPLE:**

- 0 = PFM mode operation optimized for high efficiency for all converters
- 1 = PFM mode operation optimized for low-output voltage ripple for all converters

**Bit 2 FPWM DCDC2:**

- 0 = DCDC2 converter operates in PWM / PFM mode
- 1 = DCDC2 converter is forced into fixed-frequency PWM mode

**Bit 1 FPWM DCDC1:**

- 0 = DCDC1 converter operates in PWM / PFM mode
- 1 = DCDC1 converter is forced into fixed-frequency PWM mode

**Bit 0 FPWM DCDC3:**

- 0 = DCDC3 converter operates in PWM / PFM mode
- 1 = DCDC3 converter is forced into fixed-frequency PWM mode

### 8.6.6 CON\_CTRL2 Register Address: 05h (Read and Write), Default Value: 40h

**Table 10. CON\_CTRL2 Register**

| CON_CTRL2             | B7          | B6               | B5 | B4 | B3 | B2              | B1              | B0              |
|-----------------------|-------------|------------------|----|----|----|-----------------|-----------------|-----------------|
| Bit name and function | GO          | Core adj allowed | –  | –  | –  | DCDC2 discharge | DCDC1 discharge | DCDC3 discharge |
| Default               | 0           | 1                | 0  | 0  | 0  | 0               | 0               | 0               |
| Default value loaded  | UVLO + DONE | UVLO             | –  | –  | –  | UVLO            | UVLO            | UVLO            |
| Read/write            | R/W         | R/W              | –  | –  | –  | R/W             | R/W             | R/W             |

The CON\_CTRL2 register can be used to take control the inductive converters.

Bit 7 GO:

- 0 = no change in the output voltage for the DCDC3 converter
- 1 = the output voltage of the DCDC3 converter is changed to the value defined in DEFCORE with the slew rate defined in DEFSLEW. This bit is automatically cleared when the DVM transition is complete. The transition is considered complete in this case when the desired output voltage code has been reached, not when the VDCDC3 output voltage is actually in regulation at the desired voltage.

Bit 6 CORE ADJ Allowed:

- 0 = the output voltage is set with the I<sup>2</sup>C register
- 1 = DEFDCDC3 is either connected to GND or VCC or an external voltage divider. When connected to GND or VCC, VDCDC3 defaults to 1.3 V or 1.55 V respectively at start-up

Bit 2–0 0 = the output capacitor of the associated converter is not actively discharged when the converter is disabled

- 1 = the output capacitor of the associated converter is actively discharged when the converter is disabled. This decreases the fall time of the output voltage at light load

### 8.6.7 DEFCORE Register Address: 06h (Read and Write), Default Value: 14h/1Eh

**Table 11. DEFCORE Register**

| DEFCORE               | B7 | B6 | B5 | B4       | B3       | B2       | B1       | B0       |
|-----------------------|----|----|----|----------|----------|----------|----------|----------|
| Bit name and function | –  | –  | –  | CORE4    | CORE3    | CORE2    | CORE1    | CORE0    |
| Default               | 0  | 0  | 0  | 1        | DEFDCDC3 | 1        | DEFDCDC3 | 0        |
| Default value loaded  | –  | –  | –  | RESET(1) | RESET(1) | RESET(1) | RESET(1) | RESET(1) |
| Read/write            | –  | –  | –  | R/W      | R/W      | R/W      | R/W      | R/W      |

RESET(1): DEFCORE is reset to its default value by one of these events:

- Undervoltage lockout (UVLO)
- DCDC1 AND DCDC3 disabled
- $\overline{\text{HOT\_RESET}}$  pulled low
- $\overline{\text{RESPWRON}}$  active
- VRTC below threshold

**Table 12. DCDC3 DVS Voltages**

| CORE4 | CORE3 | CORE2 | CORE1 | CORE0 | VDCDC3  | CORE4 | CORE3 | CORE2 | CORE1 | CORE0 | VDCDC3  |
|-------|-------|-------|-------|-------|---------|-------|-------|-------|-------|-------|---------|
| 0     | 0     | 0     | 0     | 0     | 0.8 V   | 1     | 0     | 0     | 0     | 0     | 1.2 V   |
| 0     | 0     | 0     | 0     | 1     | 0.825 V | 1     | 0     | 0     | 0     | 1     | 1.225 V |
| 0     | 0     | 0     | 1     | 0     | 0.85 V  | 1     | 0     | 0     | 1     | 0     | 1.25 V  |
| 0     | 0     | 0     | 1     | 1     | 0.875 V | 1     | 0     | 0     | 1     | 1     | 1.275 V |
| 0     | 0     | 1     | 0     | 0     | 0.9 V   | 1     | 0     | 1     | 0     | 0     | 1.3 V   |
| 0     | 0     | 1     | 0     | 1     | 0.925 V | 1     | 0     | 1     | 0     | 1     | 1.325 V |
| 0     | 0     | 1     | 1     | 0     | 0.95 V  | 1     | 0     | 1     | 1     | 0     | 1.35 V  |
| 0     | 0     | 1     | 1     | 1     | 0.975 V | 1     | 0     | 1     | 1     | 1     | 1.375 V |
| 0     | 1     | 0     | 0     | 0     | 1 V     | 1     | 1     | 0     | 0     | 0     | 1.4 V   |
| 0     | 1     | 0     | 0     | 1     | 1.025 V | 1     | 1     | 0     | 0     | 1     | 1.425 V |
| 0     | 1     | 0     | 1     | 0     | 1.05 V  | 1     | 1     | 0     | 1     | 0     | 1.45 V  |
| 0     | 1     | 0     | 1     | 1     | 1.075 V | 1     | 1     | 0     | 1     | 1     | 1.475 V |
| 0     | 1     | 1     | 0     | 0     | 1.1 V   | 1     | 1     | 1     | 0     | 0     | 1.5 V   |
| 0     | 1     | 1     | 0     | 1     | 1.125 V | 1     | 1     | 1     | 0     | 1     | 1.525 V |
| 0     | 1     | 1     | 1     | 0     | 1.15 V  | 1     | 1     | 1     | 1     | 0     | 1.55 V  |
| 0     | 1     | 1     | 1     | 1     | 1.175 V | 1     | 1     | 1     | 1     | 1     | 1.6 V   |

### 8.6.8 DEFSLEW Register Address: 07h (Read and Write), Default Value: 06h

**Table 13. DEFSLEW Register**

| DEFSLEW               | B7 | B6 | B5 | B4 | B3 | B2    | B1    | B0    |
|-----------------------|----|----|----|----|----|-------|-------|-------|
| Bit name and function | –  | –  | –  | –  | –  | SLEW2 | SLEW1 | SLEW0 |
| Default               | –  | –  | –  | –  | –  | 1     | 1     | 0     |
| Default value loaded  | –  | –  | –  | –  | –  | UVLO  | UVLO  | UVLO  |
| Read/write            | –  | –  | –  | –  | –  | R/W   | R/W   | R/W   |

**Table 14. DCDC3 DVS Slew Rate**

| SLEW2 | SLEW1 | SLEW0 | VDCDC3 SLEW RATE |
|-------|-------|-------|------------------|
| 0     | 0     | 0     | 0.15 mV/μs       |
| 0     | 0     | 1     | 0.3 mV/μs        |
| 0     | 1     | 0     | 0.6 mV/μs        |
| 0     | 1     | 1     | 1.2 mV/μs        |
| 1     | 0     | 0     | 2.4 mV/μs        |
| 1     | 0     | 1     | 4.8 mV/μs        |
| 1     | 1     | 0     | 9.6 mV/μs        |
| 1     | 1     | 1     | Immediate        |

### 8.6.9 LDO\_CTRL Register Address: 08h (Read and Write), Default Value: Set With DEFLDO1 and DEFLDO2

**Table 15. LDO\_CTRL Register**

| LDO_CTRL              | B7 | B6      | B5      | B4      | B3 | B2      | B1      | B0      |
|-----------------------|----|---------|---------|---------|----|---------|---------|---------|
| Bit name and function | –  | LDO2_2  | LDO2_1  | LDO2_0  | –  | LDO1_2  | LDO1_1  | LDO1_0  |
| Default               | –  | DEFLDOx | DEFLDOx | DEFLDOx | –  | DEFLDOx | DEFLDOx | DEFLDOx |
| Default value loaded  | –  | UVLO    | UVLO    | UVLO    | –  | UVLO    | UVLO    | UVLO    |
| Read/write            | –  | R/W     | R/W     | R/W     | –  | R/W     | R/W     | R/W     |

The LDO\_CTRL registers can be used to set the output voltage of LDO1 and LDO2.

The default voltage is set with DEFLDO1 and DEFLDO2 pins as described in [Table 16](#).

**Table 16. LDO2 and LDO3 I2C Voltage Options**

| LDO1_2 | LDO1_1 | LDO1_0 | LDO1 OUTPUT VOLTAGE |  | LDO2_2 | LDO2_1 | LDO2_0 | LDO2 OUTPUT VOLTAGE |
|--------|--------|--------|---------------------|--|--------|--------|--------|---------------------|
| 0      | 0      | 0      | 1 V                 |  | 0      | 0      | 0      | 1.05 V              |
| 0      | 0      | 1      | 1.1 V               |  | 0      | 0      | 1      | 1.2 V               |
| 0      | 1      | 0      | 1.35 V              |  | 0      | 1      | 0      | 1.3 V               |
| 0      | 1      | 1      | 1.5 V               |  | 0      | 1      | 1      | 1.8 V               |
| 1      | 0      | 0      | 2.2 V               |  | 1      | 0      | 0      | 2.5 V               |
| 1      | 0      | 1      | 2.6 V               |  | 1      | 0      | 1      | 2.8 V               |
| 1      | 1      | 0      | 2.85 V              |  | 1      | 1      | 0      | 3 V                 |
| 1      | 1      | 1      | 3.15 V              |  | 1      | 1      | 1      | 3.3 V               |

## 9 Application and Implementation

### NOTE

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

### 9.1 Application Information

#### 9.1.1 Input Voltage Connection

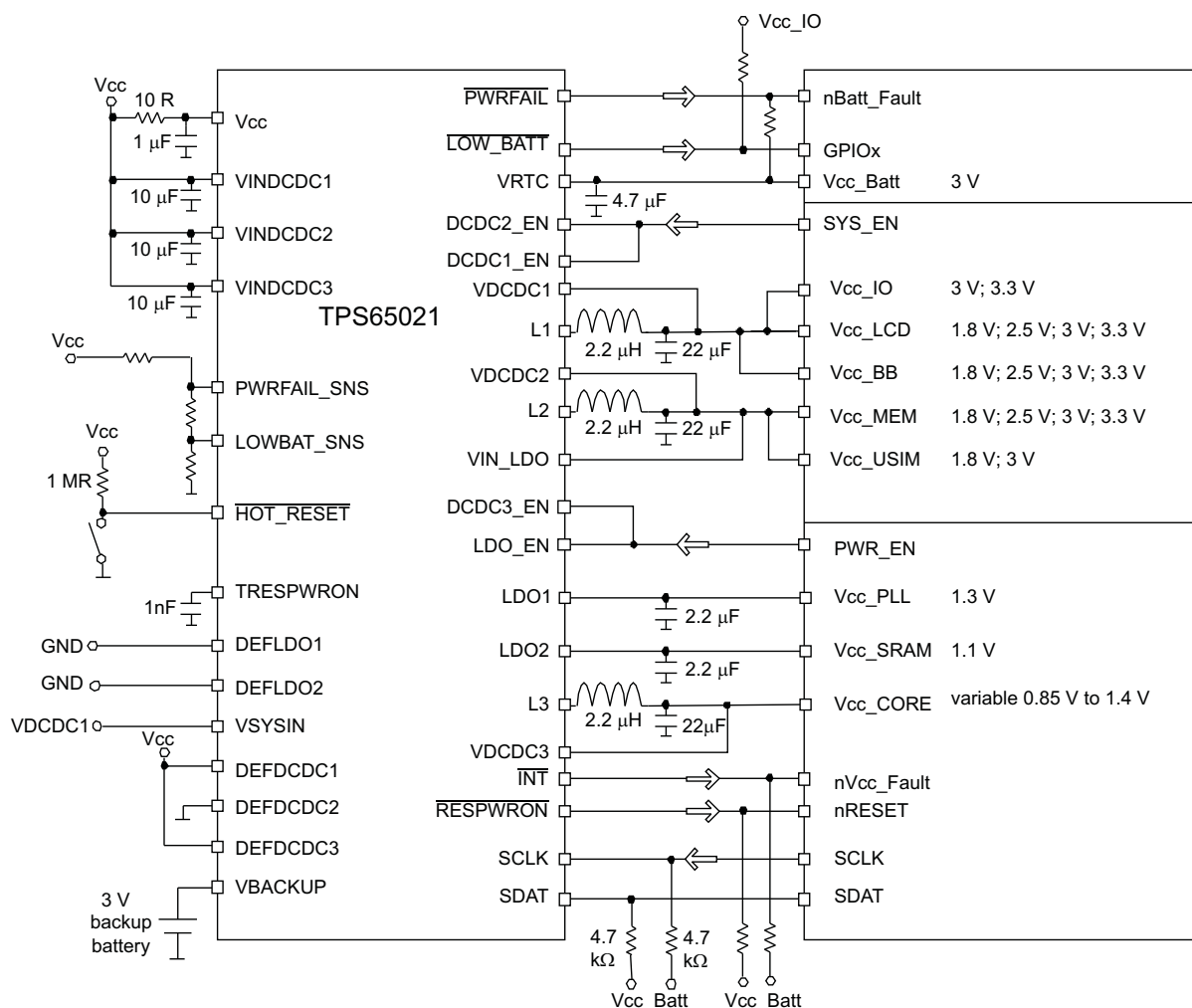
The low power section of the control circuit for the step-down converters DCDC1, DCDC2, and DCDC3 is supplied by the VCC pin while the circuitry with high power such as the power stage is powered from the VINDCDC1, VINDCDC2, and VINDCDC3 pins. For proper operation of the step-down converters, VINDCDC1, VINDCDC2, VINDCDC3, and VCC need to be tied to the same voltage rail. Step-down converters that are planned to be not used, still need to be powered from their input pin on the same rails than the other step-down converters and V<sub>CC</sub>.

LDO1 and LDO2 share a supply voltage pin which can be powered from the V<sub>CC</sub> rails or from a voltage lower than V<sub>CC</sub>, for example, the output of one of the step-down converters as long as it is operated within the input voltage range of the LDOs. If both LDOs are not used, the VINLDO pin can be tied to GND.

#### 9.1.2 Unused Regulators

In case a step-down converter is not used, its input supply voltage pin VINDCDCx still needs to be connected to the V<sub>CC</sub> rail along with supply input of the other step-down converters. TI recommends closing the control loop such that an inductor and output capacitor is added in the same way as it would be when operated normally. If one of the LDOs is not used, its output capacitor must be added as well. If both LDOs are not used, the input supply pin as well as the output pins of the LDOs (VINLDO, VLDO1, VLDO2) must be tied to GND.

## 9.2 Typical Application



**Figure 35. Typical Configuration for the Intel PXA270 Bulverde Processor**

### 9.2.1 Design Requirements

The TPS6502x devices have only a few design requirements. Use the following parameters for the design examples:

- 1-µF bypass capacitor on VCC, located as close as possible to the VCC pin to ground
- VCC and VINDCDCx must be connected to the same voltage supply with minimal voltage difference.
- Input capacitors must be present on the VINDCDCx and VIN\_LDO supplies if used
- Output inductor and capacitors must be used on the outputs of the DCDC converters if used
- Output capacitors must be used on the outputs of the LDOs if used

### 9.2.2 Detailed Design Procedure

#### 9.2.2.1 Inductor Selection for the DC-DC Converters

Each of the converters in the TPS65021 typically use a 3.3-µH output inductor. Larger or smaller inductor values are used to optimize the performance of the device for specific operation conditions. The selected inductor has to be rated for its DC resistance and saturation current. The DC resistance of the inductance influences directly the efficiency of the converter. Therefore, an inductor with lowest DC resistance must be selected for highest efficiency.

For a fast transient response, a 2.2-µH inductor in combination with a 22-µF output capacitor is recommended.

## Typical Application (continued)

**Equation 8** calculates the maximum inductor current under static load conditions. The saturation current of the inductor must be rated higher than the maximum inductor current as calculated with **Equation 8**. This is needed because during heavy load transient the inductor current rises above the value calculated with **Equation 8** and **Equation 9**.

$$\Delta I_L = V_{out} \times \frac{1 - \frac{V_{out}}{V_{in}}}{L \times f} \quad (8)$$

$$I_{Lmax} = I_{outmax} + \frac{\Delta I_L}{2}$$

where

- f = Switching frequency (1.5 MHz typical)
  - L = Inductor value
  - $\Delta I_L$  = Peak-to-peak inductor ripple current
  - $I_{LMAX}$  = Maximum Inductor current
- (9)

The highest inductor current occurs at maximum  $V_{in}$ .

Open-core inductors have a soft saturation characteristic, and they can usually handle higher inductor currents versus a comparable shielded inductor.

A more conservative approach is to select the inductor current rating just for the maximum switch current of the TPS65021 (2 A for the VDCDC1 and VDCDC2 converters, and 1.5 A for the VDCDC3 converter). The core material from inductor to inductor differs and has an impact on the efficiency especially at high switching frequencies.

See **Table 17** and the typical applications for possible inductors.

**Table 17. Tested Inductors**

| DEVICE          | INDUCTOR VALUE | TYPE              | COMPONENT SUPPLIER |
|-----------------|----------------|-------------------|--------------------|
| DCDC3 converter | 3.3 $\mu$ H    | CDRH2D14NP-3R3    | Sumida             |
|                 | 3.3 $\mu$ H    | LPS3010-332       | Coilcraft          |
|                 | 3.3 $\mu$ H    | VLF4012AT-3R3M1R3 | TDK                |
|                 | 2.2 $\mu$ H    | VLF4012AT-2R2M1R5 | TDK                |
| DCDC2 converter | 3.3 $\mu$ H    | CDRH2D18/HPNP-3R3 | Sumida             |
|                 | 3.3 $\mu$ H    | VLF4012AT-3R3M1R3 | TDK                |
|                 | 2.2 $\mu$ H    | VLCF4020-2R2      | TDK                |
| DCDC1 converter | 3.3 $\mu$ H    | CDRH3D14/HPNP-3R2 | Sumida             |
|                 | 3.3 $\mu$ H    | CDRH4D28C-3R2     | Sumida             |
|                 | 3.3 $\mu$ H    | MSS5131-332       | Coilcraft          |
|                 | 2.2 $\mu$ H    | VLCF4020-2R2      | TDK                |

### 9.2.2.2 Output Capacitor Selection

The advanced fast response voltage mode control scheme of the inductive converters implemented in the TPS65021 allow the use of small ceramic capacitors with a typical value of 10  $\mu$ F for each converter without having large output voltage under and overshoots during heavy load transients. Ceramic capacitors with low ESR values have the lowest output voltage ripple and are recommended. See **Table 18** for recommended components.

If ceramic output capacitors are used, the capacitor RMS ripple current rating always meets the application requirements. Just for completeness, the RMS ripple current is calculated as **Equation 10**.

$$I_{RMSout} = V_{out} \times \frac{1 - \frac{V_{out}}{V_{in}}}{L \times f} \times \frac{1}{2 \times \sqrt{3}} \quad (10)$$

At nominal load current, the inductive converters operate in PWM mode. The overall output voltage ripple is the sum of the voltage spike caused by the output capacitor ESR plus the voltage ripple caused by charging and discharging the output capacitor in [Equation 11](#).

$$\Delta V_{out} = V_{out} \times \frac{1 - \frac{V_{out}}{V_{in}}}{L \times f} \times \left( \frac{1}{8 \times C_{out} \times f} + ESR \right)$$

where

- the highest output voltage ripple occurs at the highest input voltage  $V_{in}$  (11)

At light-load currents, the converters operate in PSM and the output voltage ripple is dependent on the output capacitor value. The output voltage ripple is set by the internal comparator delay and the external capacitor. The typical output voltage ripple is less than 1% of the nominal output voltage.

### 9.2.2.3 Input Capacitor Selection

Because of the nature of the buck converter having a pulsating input current, a low-ESR input capacitor is required for best input voltage filtering and minimizing the interference with other circuits caused by high input voltage spikes. Each DC-DC converter requires a 10- $\mu$ F ceramic input capacitor on its input pin VINDCDCx. The input capacitor is increased without any limit for better input voltage filtering. The VCC pin is separated from the input for the DC-DC converters. A filter resistor of up to 10R and a 1- $\mu$ F capacitor is used for decoupling the VCC pin from switching noise. Note that the filter resistor may affect the UVLO threshold because up to 3 mA can flow through this resistor into the VCC pin when all converters are running in PWM mode.

**Table 18. Possible Capacitors**

| CAPACITOR VALUE | CASE SIZE | COMPONENT SUPPLIER        | COMMENTS |
|-----------------|-----------|---------------------------|----------|
| 22 $\mu$ F      | 1206      | TDK C3216X5R0J226M        | Ceramic  |
| 22 $\mu$ F      | 1206      | Taiyo Yuden JMK316BJ226ML | Ceramic  |
| 22 $\mu$ F      | 0805      | TDK C2012X5R0J226MT       | Ceramic  |
| 22 $\mu$ F      | 0805      | Taiyo Yuden JMK212BJ226MG | Ceramic  |
| 10 $\mu$ F      | 0805      | Taiyo Yuden JMK212BJ106M  | Ceramic  |
| 10 $\mu$ F      | 0805      | TDK C2012X5R0J106M        | Ceramic  |

### 9.2.2.4 Output Voltage Selection

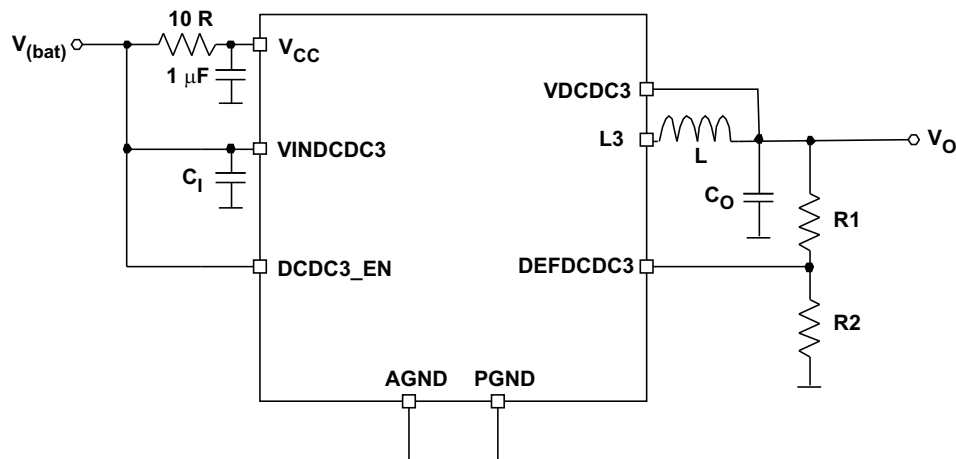
The DEFDCDC1, DEFDCDC2, and DEFDCDC3 pins are used to set the output voltage for each step-down converter. See [Table 19](#) for the default voltages if the pins are pulled to GND or to VCC. If a different voltage is needed, an external resistor divider can be added to the DEFDCDCx pin as shown in [Figure 36](#).

The output voltage of VDCDC3 is set with the I<sup>2</sup>C interface. If the voltage is changed from the default, using the DEFDCDC3 register, the output voltage only depends on the register value. Any resistor divider at DEFDCDC3 does not change the voltage set with the register.

**Table 19. Voltage Options**

| PIN      | LEVEL | DEFAULT OUTPUT VOLTAGE |
|----------|-------|------------------------|
| DEFDCDC1 | VCC   | 3.3 V                  |
|          | GND   | 3 V                    |
| DEFDCDC2 | VCC   | 2.5 V                  |
|          | GND   | 1.8 V                  |
| DEFDCDC3 | VCC   | 1.55 V                 |
|          | GND   | 1.3 V                  |

Using an external resistor divider at DEFDCDCx:



**Figure 36. External Resistor Divider**

When a resistor divider is connected to DEFDCDCx, the output voltage can be set from 0.6 V up to the input voltage  $V_{(bat)}$ . The total resistance ( $R1 + R2$ ) of the voltage divider must be kept in the 1-MR range to maintain a high efficiency at light load.

$$V_{(DEFDCDCx)} = 0.6 \text{ V}$$

$$V_{OUT} = V_{DEFDCDCx} \times \frac{R1 + R2}{R2} \quad R1 = R2 \times \left( \frac{V_{OUT}}{V_{DEFDCDCx}} \right) - R2 \quad (12)$$

#### 9.2.2.5 VRTC Output

The VRTC output is typically connected to the VCC\_BATT pin of a Intel PXA270 processor. During power-up of the processor, the TPS65021 internally switches from the LDO or the backup battery to the system voltage connected at the VSYSIN pin (see Figure 29). It is required to add a capacitor of 4.7-µF minimum to the VRTC pin, even the output may be unused.

#### 9.2.2.6 LDO1 and LDO2

The LDOs in the TPS65021 are general-purpose LDOs which are stable using ceramics capacitors. The minimum output capacitor required is 2.2 µF. The LDOs output voltage can be changed to different voltages between 1 V and 3.3 V using the I<sup>2</sup>C interface. Therefore, they can also be used as general-purpose LDOs in applications powering processors different from PXA270. The supply voltage for the LDOs needs to be connected to the VINLDO pin, giving the flexibility to connect the lowest voltage available in the system and provides the highest efficiency.

#### 9.2.2.7 TRESPWRON

This is the input to a capacitor that defines the reset delay time after the voltage at VRTC rises above 2.52 V. The timing is generated by charging and discharging the capacitor with a current of 2 µA between a threshold of 0.25 V and 1 V for 128 cycles. A 1-nF capacitor gives a delay time of 100 ms.

While there is no real upper and lower limit for the capacitor connected to TRESPWRON, TI recommends to not leave signal pins open.

$$t_{(reset)} = 2 \times 128 \times \left( \frac{(1 \text{ V} - 0.25 \text{ V}) \times C_{(reset)}}{2 \mu\text{A}} \right)$$

where

- $t_{(reset)}$  is the reset delay time
  - $C_{(reset)}$  is the capacitor connected to the TRESPWRON pin
- (13)

## TPS65021

SLVS613D – OCTOBER 2005 – REVISED DECEMBER 2015

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The minimum and maximum values for the timing parameters called ICONST (2  $\mu$ A), TRESPWRON\_UTH (1 V) and TRESPWRON\_LOWTH (0.25 V) can be found in [Specifications](#).

### 9.2.2.8 $V_{CC}$ Filter

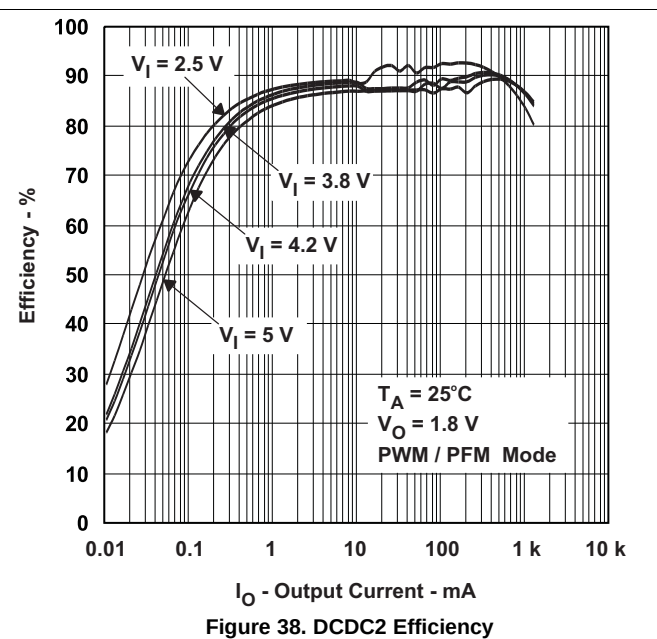
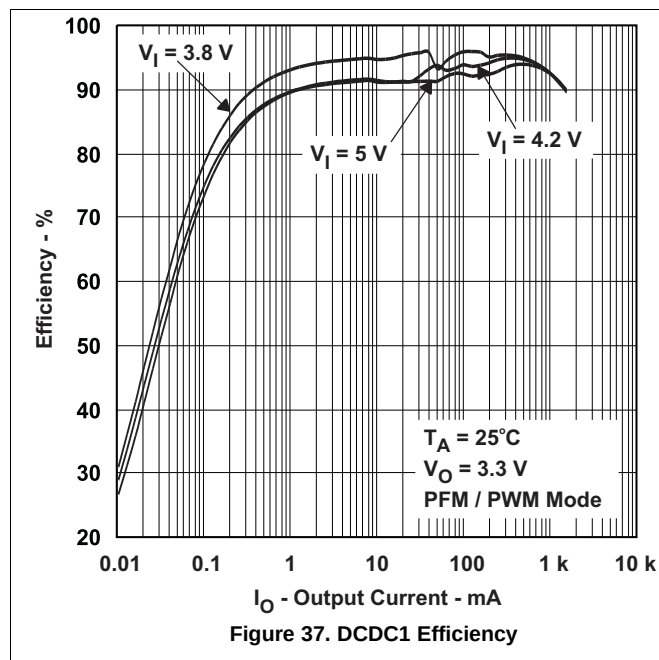
An RC filter connected at the VCC input is used to prevent noise from the internal supply for the bandgap and other analog circuitry. A typical resistor value of 1  $\Omega$  and 1  $\mu$ F is used to filter the switching spikes generated by the DC-DC converters. A resistor larger than 10  $\Omega$  must not be used because the current (up to 3 mA) into VCC causes a voltage drop at the resistor. This causes the undervoltage lockout circuitry connected internally at VCC to switch off too early.

### 9.2.3 Application Curves

Graphs were taken using the EVM with the inductor and output capacitor combinations in [Table 20](#).

**Table 20. Inductor and Output Capacitor Combinations**

| CONVERTER | INDUCTOR          | OUTPUT CAPACITOR | OUTPUT CAPACITOR VALUE    |
|-----------|-------------------|------------------|---------------------------|
| VDCDC1    | VLCF4020-2R2      | C2012X5R0J106M   | $2 \times 10 \mu\text{F}$ |
| VDCDC2    | VLCF4020-2R2      | C2012X5R0J106M   | $2 \times 10 \mu\text{F}$ |
| VDCDC3    | VLF4012AT-2R2M1R5 | C2012X5R0J106M   | $2 \times 10 \mu\text{F}$ |



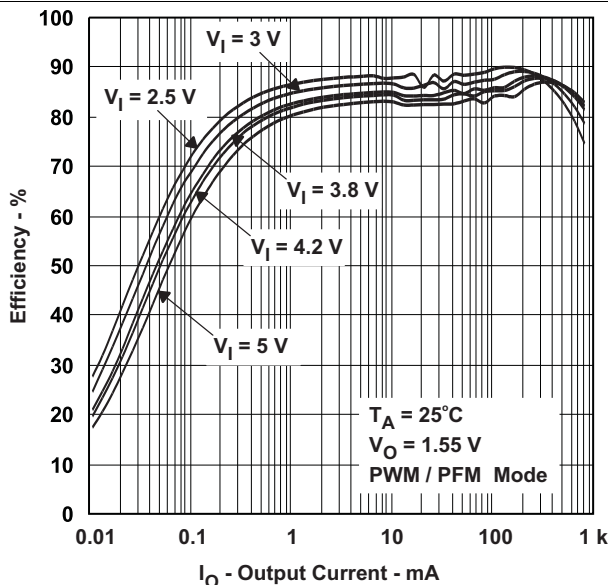


Figure 39. DCDC3 Efficiency

## 10 Power Supply Recommendations

### 10.1 Requirements for Supply Voltages below 3.0 V

For a supply voltage on pins V<sub>CC</sub>, VINDCDC1, VINDCDC2, and VINDCDC3 below 3.0 V, TI recommends enabling the DCDC1, DCDC2 and DCDC3 converters in sequence. If all 3 step-down converters are enabled at the same time while the supply voltage is close to the internal reset detection threshold, a reset may be generated during power-up. Therefore TI recommends enabling the DC-DC converters in sequence. This can be done by driving one or two of the enable pins with a RC delay or by driving the enable pin by the output voltage of one of the other step-down converters. If a voltage above 3.0 V is applied on pin VBACKUP while V<sub>CC</sub> and VINDCDCx is below 3.0 V, there is no restriction in the power-up sequencing as VBACKUP is used to power the internal circuitry.

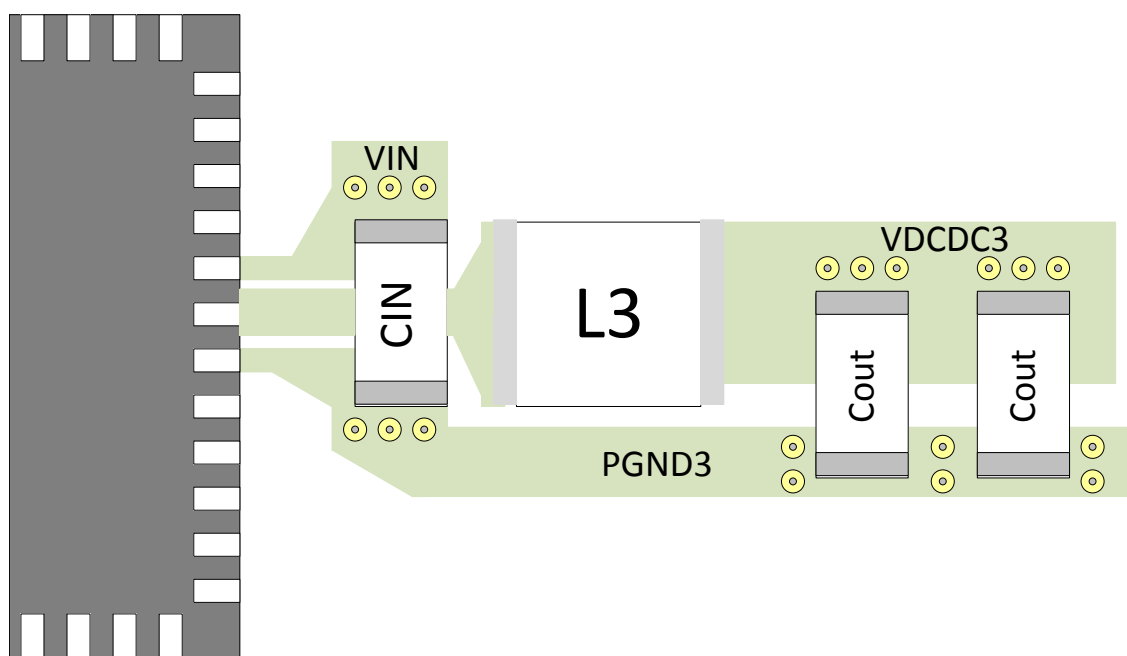
## 11 Layout

### 11.1 Layout Guidelines

As for all switching power supplies, the layout is an important step in the design. Proper function of the device demands careful attention to PCB layout. Take care in board layout to get the specified performance. If the layout is not carefully done, the regulators may show poor line, load regulation, or both, and stability issues as well as EMI problems. It is critical to provide a low impedance ground path. Therefore, use wide and short traces for the main current paths. The input capacitors must be placed as close as possible to the IC pins as well as the inductor and output capacitor.

For TPS65021, connect the PGND pins of the device to the PowerPAD land of the PCB and connect the analog ground connections (AGND) to the PGND at the PowerPAD. It is essential to provide a good thermal and electrical connection of all GND pins using multiples through to the GND-plane. Keep the common path to the AGND pins, which returns the small signal components, and the high current of the output capacitors as short as possible to avoid ground noise. The VDCDCx line must be connected right to the output capacitor and routed away from noisy components and traces (for example, the L1, L2 and L3 traces).

### 11.2 Layout Example



**Figure 40. Layout Example of a DC–DC Converter**

## 12 Device and Documentation Support

### 12.1 Device Support

#### 12.1.1 Third-Party Products Disclaimer

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### 12.4 Electrostatic Discharge Caution



These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

### 12.5 Glossary

[SLYZ022](#) — *TI Glossary*.

This glossary lists and explains terms, acronyms, and definitions.

## 13 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

## PACKAGING INFORMATION

| Orderable part number        | Status<br>(1) | Material type<br>(2) | Package   Pins  | Package qty   Carrier | RoHS<br>(3) | Lead finish/<br>Ball material<br>(4) | MSL rating/<br>Peak reflow<br>(5) | Op temp (°C) | Part marking<br>(6) |
|------------------------------|---------------|----------------------|-----------------|-----------------------|-------------|--------------------------------------|-----------------------------------|--------------|---------------------|
| <a href="#">TPS65021RHAR</a> | Active        | Production           | VQFN (RHA)   40 | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-3-260C-168 HR               | -40 to 85    | TPS<br>65021        |
| TPS65021RHAR.B               | Active        | Production           | VQFN (RHA)   40 | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-3-260C-168 HR               | -40 to 85    | TPS<br>65021        |
| TPS65021RHARG4               | Active        | Production           | VQFN (RHA)   40 | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-3-260C-168 HR               | -40 to 85    | TPS<br>65021        |
| TPS65021RHARG4.B             | Active        | Production           | VQFN (RHA)   40 | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-3-260C-168 HR               | -40 to 85    | TPS<br>65021        |
| <a href="#">TPS65021RHAT</a> | Active        | Production           | VQFN (RHA)   40 | 250   SMALL T&R       | Yes         | NIPDAU                               | Level-3-260C-168 HR               | -40 to 85    | TPS<br>65021        |
| TPS65021RHAT.B               | Active        | Production           | VQFN (RHA)   40 | 250   SMALL T&R       | Yes         | NIPDAU                               | Level-3-260C-168 HR               | -40 to 85    | TPS<br>65021        |

<sup>(1)</sup> **Status:** For more details on status, see our [product life cycle](#).

<sup>(2)</sup> **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

<sup>(3)</sup> **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

<sup>(4)</sup> **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

<sup>(5)</sup> **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

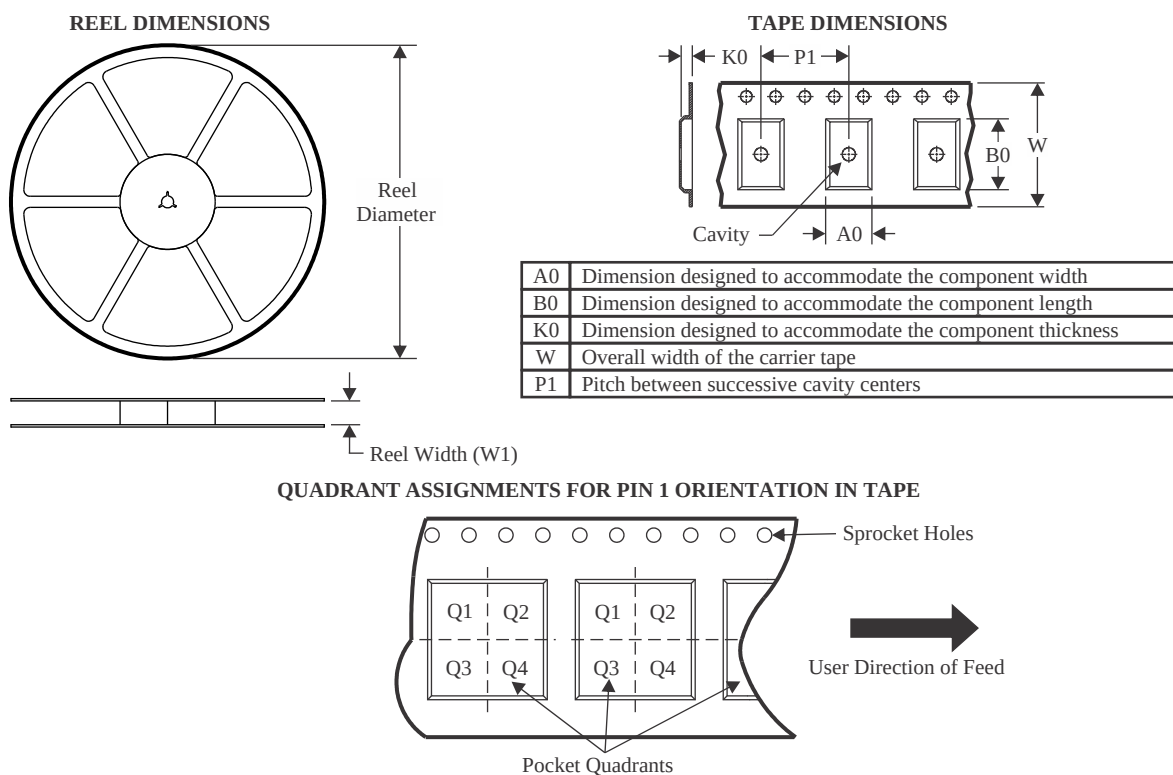
<sup>(6)</sup> **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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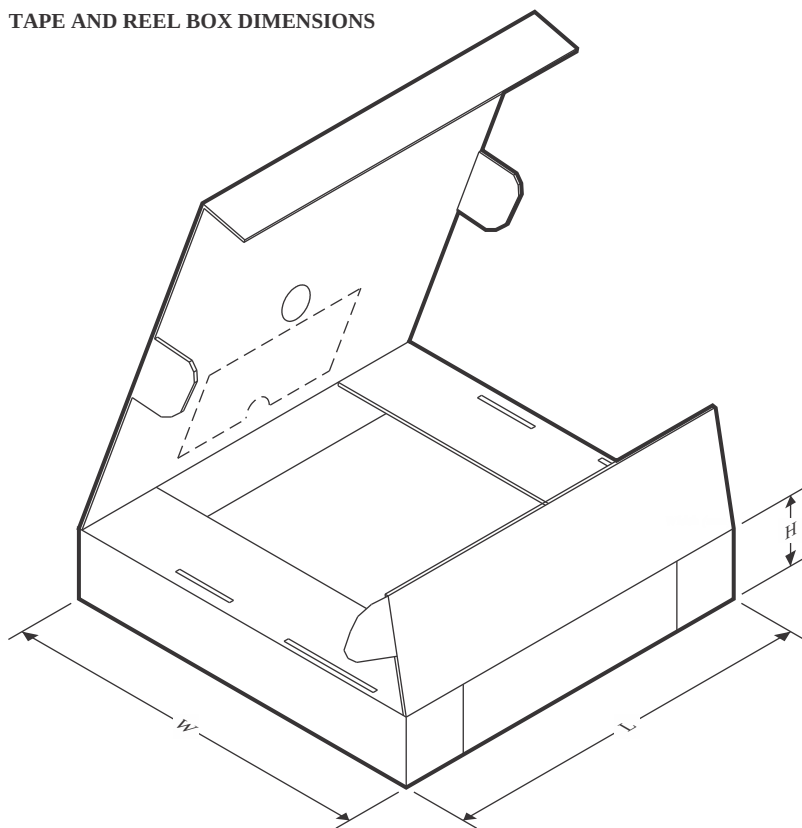
## TAPE AND REEL INFORMATION



\*All dimensions are nominal

| Device         | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|----------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| TPS65021RHAR   | VQFN         | RHA             | 40   | 2500 | 330.0              | 16.4               | 6.3     | 6.3     | 1.1     | 12.0    | 16.0   | Q2            |
| TPS65021RHARG4 | VQFN         | RHA             | 40   | 2500 | 330.0              | 16.4               | 6.3     | 6.3     | 1.1     | 12.0    | 16.0   | Q2            |
| TPS65021RHAT   | VQFN         | RHA             | 40   | 250  | 180.0              | 16.4               | 6.3     | 6.3     | 1.1     | 12.0    | 16.0   | Q2            |

## TAPE AND REEL BOX DIMENSIONS



\*All dimensions are nominal

| Device         | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|----------------|--------------|-----------------|------|------|-------------|------------|-------------|
| TPS65021RHAR   | VQFN         | RHA             | 40   | 2500 | 356.0       | 356.0      | 35.0        |
| TPS65021RHARG4 | VQFN         | RHA             | 40   | 2500 | 356.0       | 356.0      | 35.0        |
| TPS65021RHAT   | VQFN         | RHA             | 40   | 250  | 210.0       | 185.0      | 35.0        |

## GENERIC PACKAGE VIEW

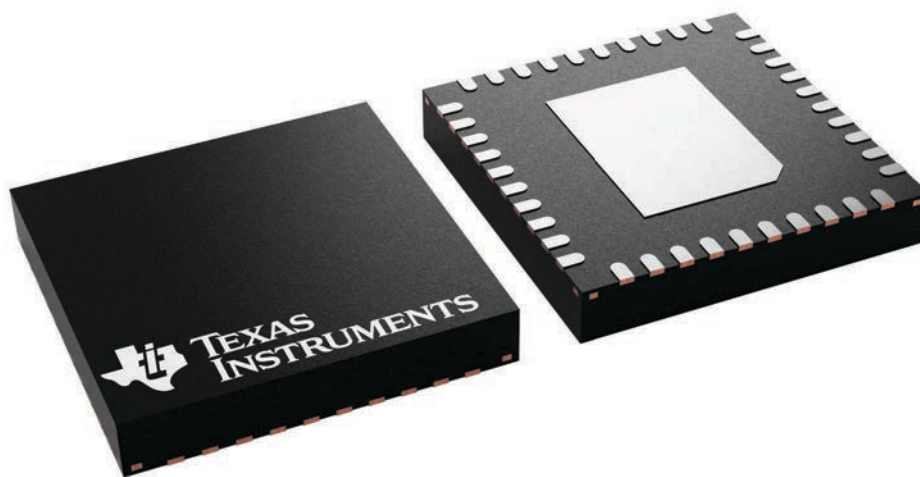
**RHA 40**

**VQFN - 1 mm max height**

6 x 6, 0.5 mm pitch

PLASTIC QUAD FLATPACK - NO LEAD

This image is a representation of the package family, actual package may vary.  
Refer to the product data sheet for package details.





### VQFN - 1 mm max height

PLASTIC QUAD FLATPACK - NO LEAD



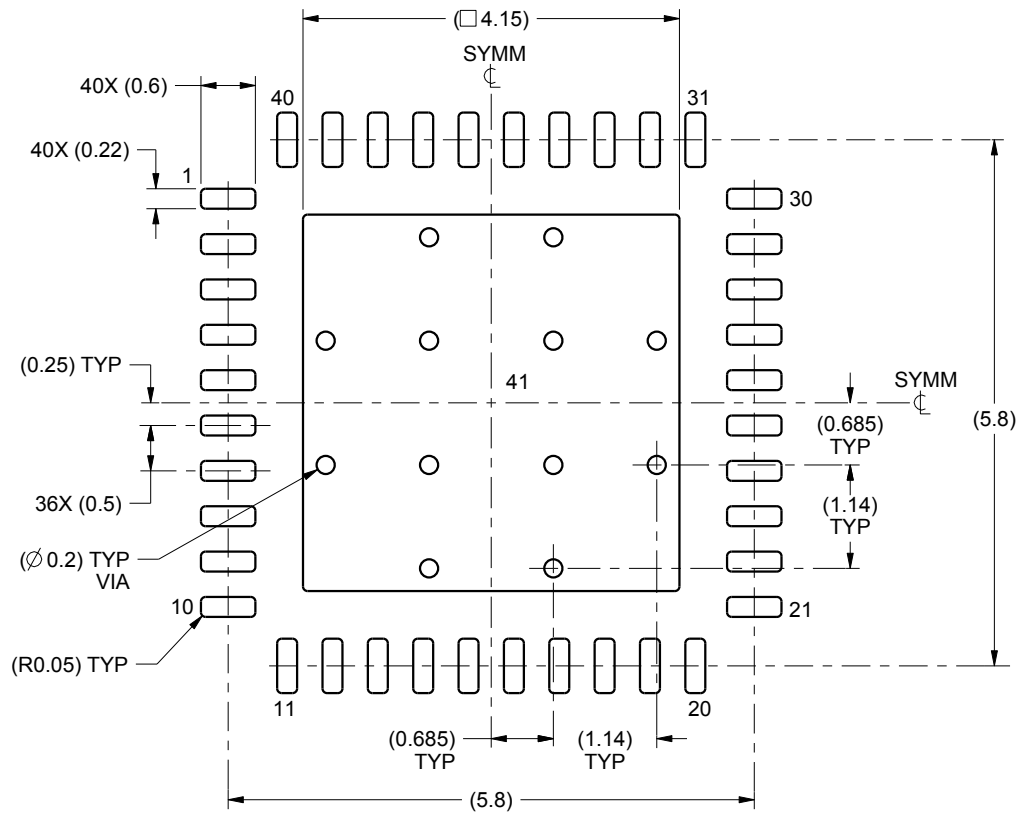
1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. The package thermal pad must be soldered to the printed circuit board for thermal and mechanical performance.

# EXAMPLE BOARD LAYOUT

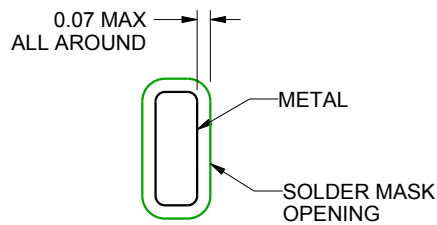
RHA0040B

VQFN - 1 mm max height

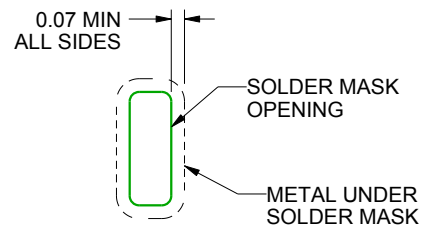
PLASTIC QUAD FLATPACK - NO LEAD



LAND PATTERN EXAMPLE  
SCALE:12X



NON SOLDER MASK  
DEFINED  
(PREFERRED)



SOLDER MASK  
DEFINED

SOLDER MASK DETAILS

4219052/A 06/2016

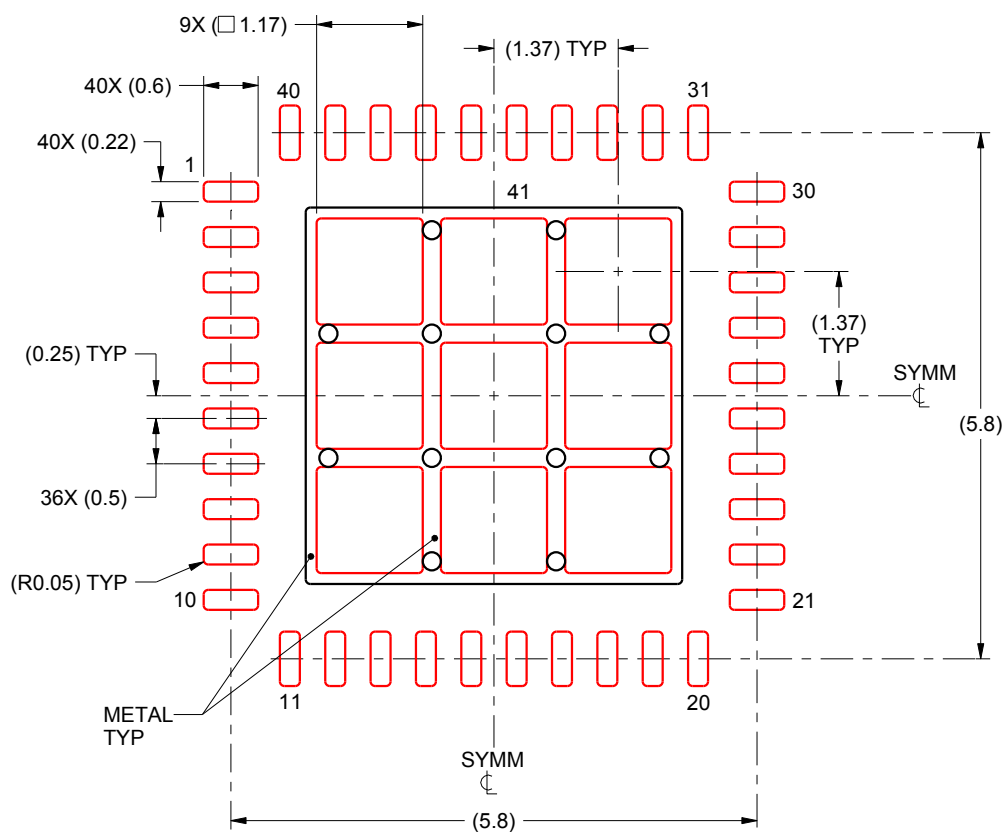
NOTES: (continued)

- This package is designed to be soldered to a thermal pad on the board. For more information, see Texas Instruments literature number SLUA271 ([www.ti.com/lit/sluea271](http://www.ti.com/lit/sluea271)).

**RHA0040B**

### VQFN - 1 mm max height

PLASTIC QUAD FLATPACK - NO LEAD



## SOLDER PASTE EXAMPLE BASED ON 0.125 mm THICK STENCIL

EXPOSED PAD 41:  
72% PRINTED SOLDER COVERAGE BY AREA UNDER PACKAGE  
SCALE:12X

4219052/A 06/2016

NOTES: (continued)

5. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.

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